#### Instruction Manual

### Model 7021 Multiplexer-Digital I/O Card

Contains Operating and Servicing Information



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### Model 7021 Multiplexer-Digital I/O Card Instruction Manual

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### **Manual Print History**

The print history shown below lists the printing dates of all Revisions and Addenda created for this manual. The Revision Level letter increases alphabetically as the manual undergoes subsequent updates. Addenda, which are released between Revisions, contain important change information that the user should incorporate immediately into the manual. Addenda are numbered sequentially. When a new Revision is created, all Addenda associated with the previous Revision of the manual are incorporated into the new Revision of the manual. Each new Revision includes a revised copy of this print history page.

| Revision A (Document Number 7021-901-01) | May 1997 |
|--|----------|

# **Safety Precautions**

The following safety precautions should be observed before using this product and any associated instrumentation. Although some instruments and accessories would normally be used with non-hazardous voltages, there are situations where hazardous conditions may be present.

This product is intended for use by qualified personnel who recognize shock hazards and are familiar with the safety precautions required to avoid possible injury. Read the operating information carefully before using the product.

The types of product users are:

**Responsible body** is the individual or group responsible for the use and maintenance of equipment, and for ensuring that operators are adequately trained.

**Operators** use the product for its intended function. They must be trained in electrical safety procedures and proper use of the instrument. They must be protected from electric shock and contact with hazardous live circuits.

Maintenance personnel perform routine procedures on the product to keep it operating, for example, setting the line voltage or replacing consumable materials. Maintenance procedures are described in the manual. The procedures explicitly state if the operator may perform them. Otherwise, they should be performed only by service personnel.

Service personnel are trained to work on live circuits, and perform safe installations and repairs of products. Only properly trained service personnel may perform installation and service procedures.

Exercise extreme caution when a shock hazard is present. Lethal voltage may be present on cable connector jacks or test fixtures. The American National Standards Institute (ANSI) states that a shock hazard exists when voltage levels greater than 30V RMS, 42.4V peak, or 60VDC are present. A good safety practice is to expect that hazardous voltage is present in any unknown circuit before measuring.

Users of this product must be protected from electric shock at all times. The responsible body must ensure that users are prevented access and/or insulated from every connection point. In some cases, connections must be exposed to potential human contact. Product users in these circumstances must be trained to protect themselves from the risk of electric shock. If the circuit is capable of operating at or above 1000 volts, no conductive part of the circuit may be exposed.

As described in the International Electrotechnical Commission (IEC) Standard IEC 664, digital multimeter measuring circuits (e.g., Keithley Models 175A, 199, 2000, 2001, 2002, and 2010) measuring circuits are Installation Category II. All other instruments' signal terminals are Installation Category I and must not be connected to mains.

Do not connect switching cards directly to unlimited power circuits. They are intended to be used with impedance limited sources. NEVER connect switching cards directly to AC mains. When connecting sources to switching cards, install protective devices to limit fault current and voltage to the card.

Before operating an instrument, make sure the line cord is connected to a properly grounded power receptacle. Inspect the connecting cables, test leads, and jumpers for possible wear, cracks, or breaks before each use.

For maximum safety, do not touch the product, test cables, or any other instruments while power is applied to the circuit under test. ALWAYS remove power from the entire test system and discharge any capacitors before: connecting or disconnecting cables or jumpers, installing or removing switching cards, or making internal changes, such as installing or removing jumpers.

Do not touch any object that could provide a current path to the common side of the circuit under test or power line (earth) ground. Always make measurements with dry hands while standing on a dry, insulated surface capable of withstanding the voltage being measured.

Do not exceed the maximum signal levels of the instruments and accessories, as defined in the specifications and operating information, and as shown on the instrument or test fixture panels, or switching card.

When fuses are used in a product, replace with same type and rating for continued protection against fire hazard.

Chassis connections must only be used as shield connections for measuring circuits, NOT as safety earth ground connections.

If you are using a test fixture, keep the lid closed while power is applied to the device under test. Safe operation requires the use of a lid interlock.

If a  $\stackrel{\triangle}{=}$  screw is present, connect it to safety earth ground using the wire recommended in the user documentation.

The \( \frac{1}{2} \) symbol on an instrument indicates that the user should refer to the operating instructions located in the manual.

The symbol on an instrument shows that it can source or measure 1000 volts or more, including the combined effect of normal and common mode voltages. Use standard safety precautions to avoid personal contact with these voltages.

The WARNING heading in a manual explains dangers that might result in personal injury or death. Always read the associated information very carefully before performing the indicated procedure.

The **CAUTION** heading in a manual explains hazards that could damage the instrument. Such damage may invalidate the warranty.

Instrumentation and accessories shall not be connected to humans.

Before performing any maintenance, disconnect the line cord and all test cables.

To maintain protection from electric shock and fire, replacement components in mains circuits, including the power transformer, test leads, and input jacks, must be purchased from Keithley Instruments. Standard fuses, with applicable national safety approvals, may be used if the rating and type are the same. Other components that are not safety related may be purchased from other suppliers as long as they are equivalent to the original component. (Note that selected parts should be purchased only through Keithley Instruments to maintain accuracy and functionality of the product.) If you are unsure about the applicability of a replacement component, call a Keithley Instruments office for information.

To clean the instrument, use a damp cloth or mild, water based cleaner. Clean the exterior of the instrument only. Do not apply cleaner directly to the instrument or allow liquids to enter or spill on the instrument.

#### ANALOG MULTIPLEXER SPECIFICATIONS

MULTPLEXER CONFIGURATION: Independent  $1\times12$  and  $1\times18$  multiplex banks. Adjacent banks can be connected together. Jumpers can be removed to isolate any bank from the backplane.

CONTACT CONFIGURATION: \$2\$-pole Form A (HI, LO).

MAXIMUM SIGNAL: 110V DC, 110V rms, 155V peak between any two inputs or chassis, 1A switched, 30VA (resistive load).

CONTACT LIFE: Cold Switching: 108 closures.

Maximum Signal Levels: 10<sup>5</sup> closures.

CHANNEL RESISTANCE (per conductor): <1.25Ω.

CONTACT POTENTIAL:  $<3\mu V$  per channel contact pair

<9μV per single contact

OFFSET CURRENT: <100pA. ACTUATION TIME: <3ms.

ISOLATION:1

Bank:  $>10^{9}\Omega, <25 pF$ . Channel to Channel:  $>10^{9}\Omega, <50 pF$ 

**Differential:** Configured as  $1\times12$ :  $>10^{9}\Omega$ , <100pF.

Configured as  $1\times18$ :  $>10^{9}\Omega$ , <150pF. Configured as  $1\times30$ :  $>10^{9}\Omega$ , <200pF.

**Common Mode:** Configured as  $1\times12$ :  $>10^9\Omega$ , <200pF.

Configured as  $1\times18$ :  $>10^{9}\Omega$ , <250pF. Configured as  $1\times30$ :  $>10^{9}\Omega$ , <350pF.

CROSSTALK<sup>1</sup> (1MHz,  $50\Omega$  Load): <-40dB.

INSERTION LOSS¹ (50 $\Omega$  Source, 50 $\Omega$  Load): <0.25dB below 1MHz, <3dB below 10MHz.

RELAY DRIVE CURRENT (per relay): 16mA.

<sup>1</sup> Specifications apply with no more than one channel closed.

#### **DIGITAL I/O SPECIFICATIONS**

DIGITAL I/O CAPABILITY: 10 independent inputs. 10 independent outputs.

#### **OUTPUT:**

Configuration: 10 open collector drivers with factory installed  $10k\Omega$  pull-up resistors. Each driver has an internal flyback diode. Pull-Up Voltage: 5V internally supplied, external connection provided for user supplied voltage up to 42V max. Outputs short circuit protected up to 25V.

Maximum Sink Current: Per Channel: 250mA. Per Card: 1A.

**Logic:** Hardware user configurable for negative or positive true logic levels.

#### INPUT:

Configuration: 10 inputs with internal  $10k\Omega$  pull-up resistors provided. Input resistors can be set for pull-up or pull-down configuration.

MAXIMUM VOLTAGE LEVEL: 42V peak.

LOGIC: Positive true.

#### **GENERAL**

CONNECTOR TYPE: 96-pin male DIN connector.

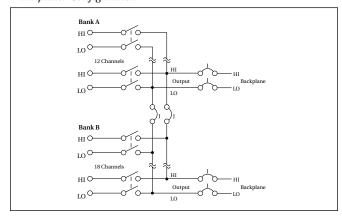
**ENVIRONMENT:** Operating: 0° to 50°C, up to 35°C <80% RH. Storage: -25° to 65°C.

EMC: Conforms with European Union Directive 89/336/EEC EN 55011, EN 50082-1, EN 61000-3-2 and 61000-3-3, FCC part 15 class B.

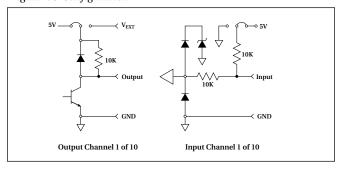
**SAFETY:** Conforms with European Union Directive 73/23/EEC EN 61010-1, UL 3111-1.

Specifications subject to change without notice.

#### Multiplexer Configuration



#### Digital I/O Configuration



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# 1

### **General Information**

#### Introduction

This section contains general information about the Model 7021 multiplexer-digital I/O card.

The Model 7021 consists of a multi-pin (mass termination) connector card and a relay card. Any external test circuit connections are made via the 96-pin male DIN connector on the connector card. Keithley offers a variety of optional accessories at the end of this section that can be used to make connections to the connector card.

The rest of Section 1 is arranged in the following manner:

- Features
- Warranty information
- Manual addenda
- Safety symbols and terms
- Specifications
- · Unpacking and inspection
- Optional accessories

#### **Features**

The Model 7021 has two-pole, independent  $1 \times 12$  and  $1 \times 18$  multiplex banks and ten independent inputs and outputs for both multiplexer and digital I/O capabilities. Some of the key features include:

- Low contact potential and offset current for minimal effects on low-level signals.
- Easy jumper configuration for one or two multiplex banks
- Backplane jumpers. Cutting jumpers disconnects multiplexer bank outputs from the Model 7001/7002 analog backplane.
- Model 7011-KIT-R connector assembly kit that includes a 96-pin female DIN connector that will mate directly to the connector on the Model 7021 or to a standard 96-pin male DIN bulkhead connector (see Model 7011-MTR). This connector uses solder cups for connections to external circuitry and includes an adapter for a round cable and the housing.

#### Warranty information

Warranty information is located on the inside front cover of this instruction manual. Should your Model 7021 require warranty service, contact the Keithley representative or authorized repair facility in your area for further information. When returning the card for repair, be sure to fill out and include the service form at the back of this manual in order to provide the repair facility with the necessary information.

#### Manual addenda

Any improvements or changes concerning the multiplexerdigital I/O card or manual will be explained in an addendum included with the card. Addenda are provided in a page replacement format. Simply replace the obsolete pages with the new pages.

#### Safety symbols and terms

The following symbols and terms may be found on an instrument or used in this manual.

The symbol on an instrument indicates that the user should refer to the operating instructions located in the instruction manual.

The symbol on an instrument shows that high voltage may be present on the terminal(s). Use standard safety precautions to avoid personal contact with these voltages.

The WARNING heading used in this manual explains dangers that might result in personal injury or death. Always read the associated information very carefully before performing the indicated procedure.

The CAUTION heading used in this manual explains hazards that could damage the card. Such damage may invalidate the warranty.

#### **Specifications**

Model 7021 specifications are found at the front of this manual. These specifications are exclusive of the mainframe specifications.

#### **Unpacking and inspection**

#### Inspection for damage

The Model 7021 is packaged in a resealable, anti-static bag to protect it from damage due to static discharge and from contamination that could degrade its performance. Before removing the card from the bag, observe the following precautions on handling.

#### **Handling precautions**

- 1. Always grasp the card by the side edges and shields. Do not touch the board surfaces or components.
- 2. When not installed in a Model 7001/7002 mainframe, keep the card in the anti-static bag and store it in the original packing carton.

After removing the card from its anti-static bag, inspect it for any obvious signs of physical damage. Report any such damage to the shipping agent immediately.

#### **Shipping contents**

The following items are included with every Model 7021 order:

- Model 7021 Multiplexer-Digital I/O Card
- Model 7011-KIT-R 96-Pin Female DIN Connector Kit
- Model 7021 Instruction Manual
- · Additional accessories as ordered

#### Instruction manual

The Model 7021 Instruction Manual is three-hole drilled so it can be added to the three-ring binder of the Model 7001 or Model 7002 Instruction Manual. After removing the plastic wrapping, place the manual in the binder following the mainframe instruction manual. Note that a manual identification tab is included and should precede the Model 7021 instruction manual.

If an additional instruction manual is required, order the manual package, Keithley part number 7021-901-01. The manual package includes an instruction manual and any pertinent addenda.

#### **Repacking for shipment**

Should it become necessary to return the Model 7021 for repair, carefully pack the unit in its original packing carton, or the equivalent, and include the following information:

- Advise as to the warranty status of the card.
- Write ATTENTION REPAIR DEPARTMENT on the shipping label.
- Fill out and include the service form located at the back of this manual.

#### **Optional accessories**

The following accessories are available for use with the Model 7021:

Model 7011-MTR — This 96-pin male DIN bulkhead connector uses solder cups for connections to external circuitry. It will mate to the Model 7011-KIT-R connector and Model 7011-MTC-2 cable assembly.

Model 7011-MTC-2 — This two-meter round cable assembly is terminated with a 96-pin female DIN connector on each end. It will mate directly to the connector on the Model 7021 and to a standard 96-pin male DIN bulkhead connector (see Model 7011-MTR).

# **Multiplexer Configuration**

#### Introduction

This section covers the basics for multiplexer switching and is arranged as follows:

- Basic multiplexer configurations Covers the basic multiplexer configurations: dual 1 × 12 and 1 × 18 configuration and single 1 × 30 configuration. The significance of the backplane jumpers is also covered here.
- Typical multiplex switching schemes Explains some
  of the basic ways a multiplexer can be used to source or
  measure. Covers single-ended switching, differential
  (floating) switching, sensing, and SMU connections.
- Multiplexer expansion Discusses the various configurations that are possible by using multiple cards.

#### **Basic multiplexer configurations**

A simplified schematic of the Model 7021 multiplex banks is shown in Figure 2-1. It is organized as two multiplex banks:  $1\times12$  and  $1\times18$ . Bank A has 12 inputs and one output, and bank B has 18 inputs and one output. Two-pole switching is provided for each multiplexer input, with HI and LO switched. The two banks can be jumpered together to expand multiplexer inputs, and backplane jumpers provide bank connections to an adjacent card installed in a Model 7001/7002 mainframe.

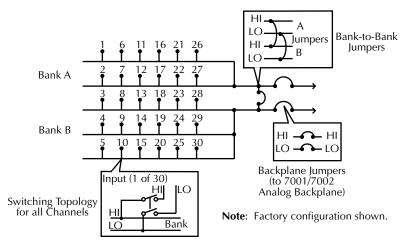


Figure 2-1
Model 7021 simplified schematic

#### Multiplexer bank-to-bank jumpers

Jumpers are installed on the connector card to connect multiplex banks together to form a  $1 \times 30$  multiplexer. Each jumper set connects two adjacent banks together. These jumper sets are included with the Model 7021.

The bank-to-bank jumpers allow you to configure the multiplexer in a variety of ways. Typical multiplexer configurations include:

- Dual  $1 \times 12$  and  $1 \times 18$  multiplex banks; no jumpers installed (Figure 2-2).
- One 1 × 30 multiplex bank; all bank-to-bank jumpers installed (Figure 2-3).

Refer to Section 4 for information on installing bank-to-bank jumpers.

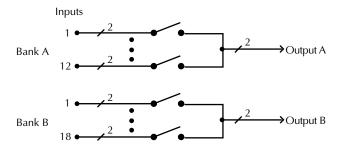


Figure 2-2 Dual  $1 \times 12$  and  $1 \times 18$  multiplexer configuration (jumpers not installed)

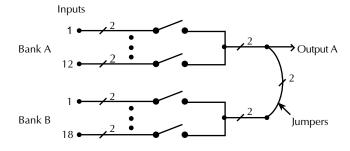


Figure 2-3 One  $1 \times 30$  multiplexer configuration (jumpers installed)

#### **Backplane jumpers**

There are four pairs of backplane jumpers located on the relay card. With the jumpers installed, the multiplex banks of one card connect to the multiplex banks of a second card through the analog backplane of the Model 7001/7002 mainframe, which expands the number of inputs. With the jumpers removed (cut), the multiplexer is isolated from another card installed in the mainframe.

The three-pole analog backplane of the Model 7001/7002 mainframe is shown in Figure 2-4. The GUARD connection of the analog backplane is found only on the mainframe and is not used with the Model 7021 or Model 7022 card. Through this analog backplane, the banks of a Model 7021 installed in one slot can be connected to the banks (or rows) of a compatible card installed in an adjacent slot.

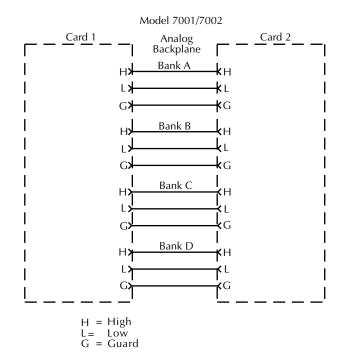


Figure 2-4
Model 7001/7002 analog backplane

Figure 2-5 shows how each bank of the Model 7021 is connected to the backplane. Notice that since the Model 7021 is a two-pole card, there is no connection made to the GUARD terminal of the backplane. The Model 7021 is shipped from the factory with the backplane jumpers installed.

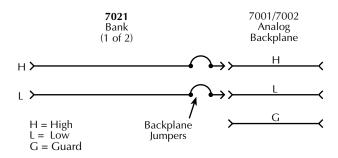


Figure 2-5
Bank connections to backplane

Removing (cutting) the backplane jumpers isolates the card from the backplane, and subsequently, any card installed in an adjacent slot. For information on removing the jumpers, refer to Section 4.

#### NOTE

The Model 7001/7002 does not provide an analog backplane for the non-701X/702X/703X series cards. As a result, any of these cards installed in one slot in the mainframe is electrically isolated from any card installed in the other slot. The only way to connect a Model 7021 to one of these cards is to wire them together.

#### **Typical multiplexer switching schemes**

The following paragraphs describe some basic switching schemes that are possible with a two-pole switching multiplexer. These switching schemes include some various shielding configurations to help minimize noise pickup in sensitive measurement applications. These shields are shown connected to chassis ground. For some test configurations, shielding may prove to be more effective connected to circuit common. Chassis ground is accessible at the rear panel of the Model 7001/7002 mainframe.

#### Single-ended switching

In the single-ended switching configuration, the source or measure instrument is connected to the DUT through a single pathway as shown in Figure 2-6. The instrument is connected to the output of one of the banks, and the DUT is shown connected to one of the inputs for that bank.

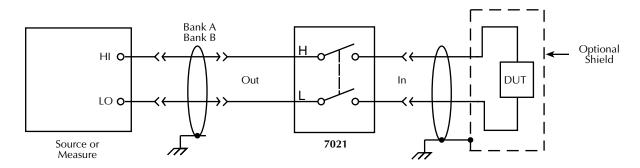


Figure 2-6
Single-ended switching example

#### **Differential switching**

The differential or floating switching configuration is shown in Figure 2-7. The advantage of using this configuration is that the terminals of the source or measure instrument are not confined to the same pathway. Each terminal of the instrument can be switched to any available input in the test system.

#### **Sensing**

Figure 2-8 shows how the multiplexer can be configured to use instruments that have sensing capability. The main advantage of using sensing is to cancel the effects of switch card path resistance (<1.25 $\Omega$ ) and the resistance of external cabling. Whenever path resistance is a consideration, sensing should be used.

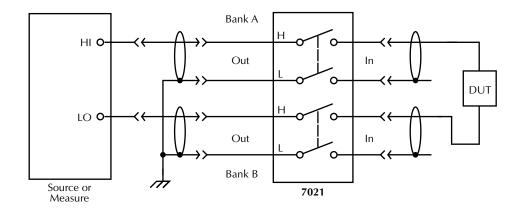


Figure 2-7
Differential switching example

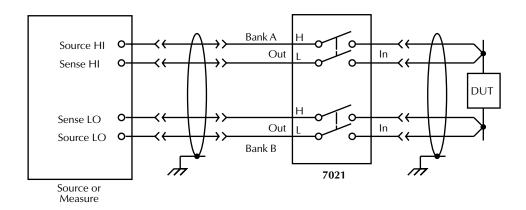


Figure 2-8
Sensing example

#### **SMU** connections

Figure 2-9 shows how to connect a Keithley Model 236, 237, or 238 Source Measure Unit to the multiplexer. By using triax cables that are unterminated at one end, the driven guard and chassis ground are physically extended all the way to the card.

#### **Multiplexer expansion**

With the use of additional switching cards and mainframes, larger systems can be configured. Each Model 7001 switch system mainframe can accommodate up to two cards, and up to six mainframes can be connected together. With this switch system, up to 12 cards can be configured. Each Model 7002 switch system mainframe can accommodate up to ten cards. And, by connecting up to six Model 7002 mainframes, 60 cards can be configured. The limits on the number of cards in the Model 7001/7002 are due to triggering.

#### Multiple-card switching systems

The Model 7001/7002 switch system mainframes can accommodate two and ten cards, respectively. The following paragraphs use a two-card system to illustrate multiple-card switching configurations.

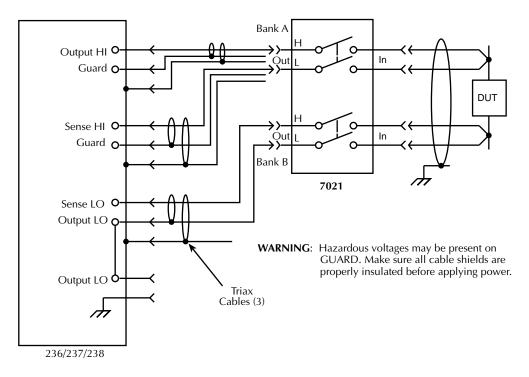


Figure 2-9
SMU connections

#### Separate switching systems

Two single-card systems can be configured by removing the backplane jumpers from one of the cards. The two cards will be controlled by the same mainframe, but they will be electrically isolated from each other. Figure 2-10 shows an example using two Model 7021 cards.

#### Multiplexer input expansion

You can double the number of multiplexer inputs by installing two "as shipped" Model 7021s in the Model 7001/7002 mainframe. By leaving the backplane jumpers installed, the multiplex banks of the card installed in slot 1 (CARD 1) are automatically connected to the multiplex banks of the card installed in slot 2 (CARD 2) through the analog backplane.

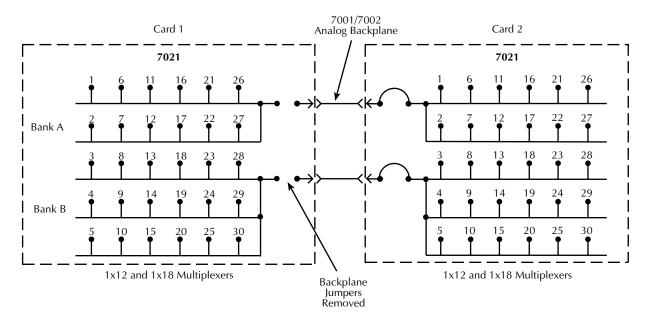


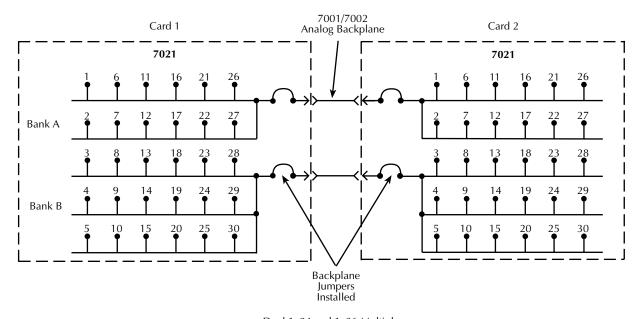
Figure 2-10
Two separate multiplexer systems

Figure 2-11 shows an example of input expansion. Each Model 7021 card is configured with dual  $1\times12$  and  $1\times18$  multiplex banks. By connecting the banks together (via the Model 7001/7002 analog backplane), the resultant multiplexer system has 24 inputs for bank A and 36 inputs for bank B. Notice that if all the bank-to-bank jumpers (for both cards) were installed, the result would be a single  $1\times60$  multiplexer.

#### Mixing card types

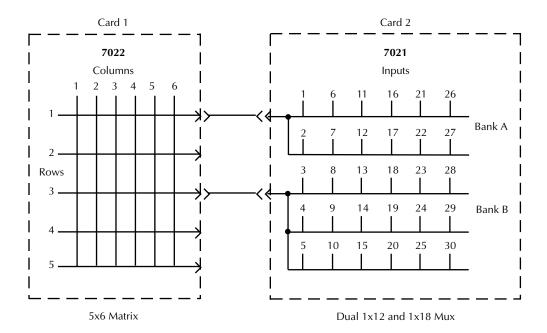
Different types of cards can be used together to create some unique switching systems. For example, you could have a Model 7021 multiplexer-digital I/O card installed in one slot and a Model 7022 matrix-digital I/O card installed in an adjacent slot.

Figure 2-12 shows a possible switching system using a matrix and a multiplexer. The backplane jumpers for both the matrix and multiplexer must be installed. This allows matrix rows to be connected to multiplex banks. On the multiplex banks, the bank-to-bank jumpers must be removed to maintain isolation between the matrix rows. See the instruction manual for the Model 7022 for complete information on the matrix.



Dual 1x24 and 1x36 Multiplexer

Figure 2-11
Multiplexer input expansion example



**Notes:** 1. Models 7021 and 7022 backplane jumpers must be removed from rows 2 and 4.

2. Model 7021 bank-to-bank jumpers must be removed.

Figure 2-12
Mixed card type example

#### Mainframe multiplexer expansion

Twelve- or 60-card multiplexer systems are possible by connecting six Model 7001 or six Model 7002 mainframes, respectively. Each Model 7021 added to the system provides 30 additional inputs. The limits on the number of cards in the Model 7001/7002 switch system are due to triggering. Section 4 explains how to connect a test system using two mainframes.

# **Digital I/O Configuration**

#### Introduction

This section covers the basic digital input and output configurations for the Model 7021. Connection information for these configurations is provided in Section 4 of this manual, while operation (front panel and IEEE-488 bus) is explained in Section 5.

#### **Digital outputs**

Output channels are user configurable for negative (low) or positive (high) true logic. That is, the output can be high or low when the channel is turned on (closed) depending upon user configuration. Conversely, the output can be high or low when the channel is turned off (open). Refer to Section 4 to configure the logic to your requirement.

#### **Controlling pull-up devices**

Typically, the digital outputs are used to provide drive for relatively high current devices such as solenoids, relays, and small motors. The configurations for these applications are shown in Figure 3-1. Figure 3-1 allows you to use an external voltage source (V) for devices that require a higher voltage (42V maximum). An internal jumper is used to select the internal pull-up voltage. At the factory, the internal 5V source is selected.

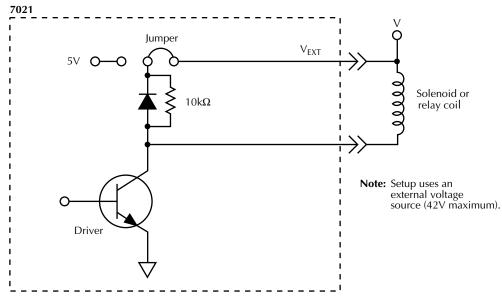


Figure 3-1
Output configuration for pull-up devices

Each output channel uses a fly-back diode for protection when switching an inductive device, such as a solenoid coil. This diode diverts the potentially damaging fly-back voltage away from the driver.

#### **CAUTION**

Failure to set J201 to the  $V_{\text{ext}}$  position when using external pull-up voltages may result in damage to the output drivers.

#### Controlling devices using pull-up resistors

When interfacing outputs to high-impedance devices (i.e. logic devices), internal pull-up resistors are used to achieve the appropriate logic level. Figure 3-2 shows the output configuration using the  $10k\Omega$  pull-up resistor (R<sub>p</sub>).

The configuration in Figure 3-2 uses the internal 5V source as the high logic level. If you need a higher logic level, you can place the jumper in the alternate position and apply an external voltage (via  $V_{\rm EXT}$ ).

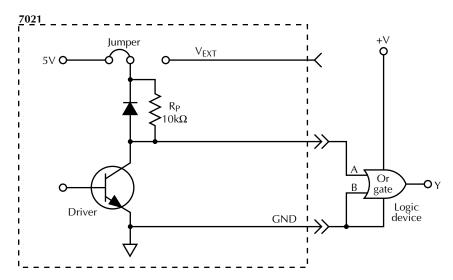


Figure 3-2
Output configuration using pull-up resistance

#### **Digital inputs**

Input channels use positive true logic but can be pulled up or pulled down based on the configuration of the pull-up resistor. Each channel uses a  $10k\Omega$  pull-up resistor  $(R_1)$ . The pull-up resistors can be pulled up to 5V or pulled down to ground depending on the positioning of the jumper on the input logic bank. Refer to Section 4 for more information. Figure 3-3 shows the resistor being pulled up to 5V.

When the resistor is connected to 5V, the channel is pulled high. Thus, with nothing connected to the channel, the input is pulled high to 5V which displays the channel as on.

When the resistor is connected to ground, the channel is pulled low. Thus, with nothing connected to the channel, the input is pulled low to ground which displays the channel as off.

The digital input is compatible with external TTL logic. Each built-in pull-up resistor provides level shifting so devices such as micro-switches can be monitored. Each input has a protection network that clamps the input at 5.7V. This allows logic levels up to 42V peak to be monitored.

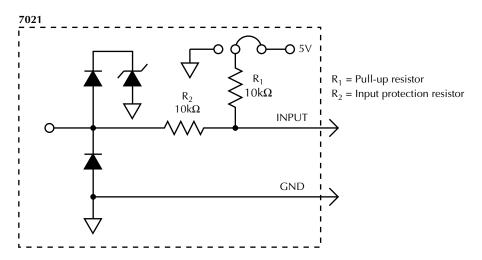


Figure 3-3
Input configuration

4

# Card Connections and Installation

#### Introduction

#### **WARNING**

The procedures in this section are intended only for qualified service personnel. Do not perform these procedures unless qualified to do so. Failure to recognize and observe normal safety precautions could result in personal injury or death.

The information in this section is arranged as follows:

- Handling precautions Explains precautions that must be followed to prevent contamination to the card. Contamination could degrade the performance of the card.
- Multiplexer connections Covers the basics for connecting external circuitry to the connector card.
- Digital I/O connections Explains the voltage source jumpers, pull-up resistors, output logic, and input resistance and how to configure them.
- Multi-pin (mass termination) connector card Covers the basic connections to the 96-pin DIN male connector and identifies each terminal.
- Typical multiplexer connection schemes Provides some typical connection schemes for single card, twocard and two-mainframe system configurations.

- Typical digital I/O connection schemes Provides some typical connection schemes for output solenoid, relay, motor, and logic device control and for input micro-switch monitoring.
- Model 7021 installation and removal Provides the procedures to install and remove the Model 7021 card from the Model 7001/7002 mainframe.

#### **Handling precautions**

To maintain high impedance isolation, care should be taken when handling the relay and connector cards to avoid contamination from such foreign materials as body oils. Such contamination can substantially lower leakage resistances, thus degrading performance.

To avoid possible contamination, always grasp the relay and connector cards by the side edges or shields. Do not touch the board surfaces or components. On connectors, do not touch areas adjacent to the electrical contacts. Dirt buildup over a period of time is another possible source of contamination. To avoid this problem, operate the mainframe and card in a clean environment.

If a card becomes contaminated, it should be thoroughly cleaned as explained in Section 6.

#### **Multiplexer connections**

The following paragraphs provide the basic information needed to connect your external test circuitry to the multiplexer. The removal and installation of the backplane row jumpers on the relay card and the bank-to-bank jumpers on the connector card are included.

#### WARNING

The following connection information is intended to be used by qualified service personnel. Failure to recognize and observe standard safety precautions could result in personal injury or death.

#### **Backplane row jumpers**

The Model 7001/7002 mainframe has an analog backplane that allows the multiplex banks of a Model 7021 to be internally connected to a compatible switching card installed in the adjacent slot (See Section 2 for details).

The backplane row jumpers for the card are located on the relay card as shown in Figure 4-1. The card is shipped from the factory with the jumpers installed.

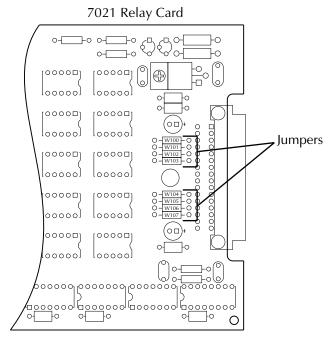


Figure 4-1
Backplane row jumpers

#### Backplane row jumper removal

Perform the following steps to remove the backplane row jumpers:

- If mated together, separate the relay card from the connector card by removing the mounting screw and then pulling the two cards away from each other. Remember to only handle the cards by the edges and shields to avoid contamination.
- 2. Use Figure 4-1 to locate the jumper(s) to be removed.
- 3. It is not necessary to physically remove the jumpers from the PC board. Using a pair of wire cutters, cut one lead of each jumper.

#### Backplane row jumper installation

Referring to Figure 4-1 for jumper locations, perform the following steps to install the backplane row jumpers:

- If mated together, separate the relay card from the connector card by removing the mounting screw and then pulling the two cards away from each other. Remember to only handle the cards by the edges and shields to avoid contamination.
- Physically remove a cut jumper by unsoldering it from the PC board.
- 3. Install a new #22 AWG jumper wire (Keithley P/N J-15) and solder it to the PC board.
- 4. Remove the solder flux from the PC board. The cleaning procedure is explained in Section 6.

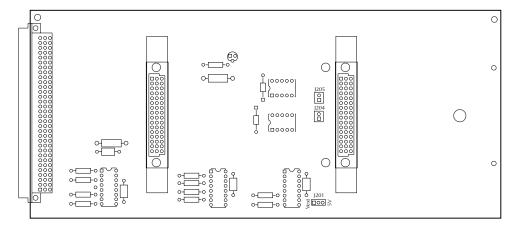


Figure 4-2
Bank-to-bank jumper locations

#### **Bank-to-bank jumpers**

As explained in Section 2, the multiplex banks can be connected together (using plug-in jumpers) to form large multiplexers. The locations of the bank-to-bank jumper terminals for the connector card are shown in Figure 4-2.

On the illustration, the two terminal pairs are labeled J204 and J205. J204 is used to connect the HI terminals of the banks. J205 is used to connect the LO terminals of the banks. Referring to Figure 4-2 for jumper locations, perform the following steps to install or remove bank-to-bank jumpers:

- If mated together, separate the relay card from the connector card by removing the mounting screw and pulling the two cards away from each other. Remember to only handle the cards by the edges and shields to avoid contamination.
- 2. Refer to Figure 4-2 to determine which jumpers to install or remove.
- 3. Using Figure 4-3 as a guide, install the jumpers on, or remove the jumpers from, the appropriate terminal pairs.

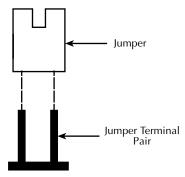


Figure 4-3
Bank-to-bank jumper installation

#### **Digital I/O connections**

#### **Voltage source jumper**

Digital output uses the internal +5V source as the high logic level. If higher voltages are required, a user-supplied voltage can be used (42V maximum). At the factory, the internal jumper is set to use the internal +5V source.

#### **CAUTION**

Failure to set J201 to the  $V_{\text{ext}}$  position when using external pull-up voltages may result in damage to the output drivers.

A plug-in jumper for the bank allows you to select the internal +5V source or an external source. In Figure 4-4, the banks are using the external voltage source.

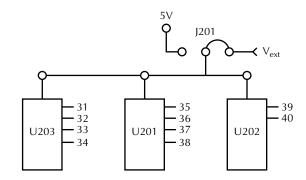


Figure 4-4
Voltage source jumper for output channels

The voltage source jumper is located on the connector board as shown in Figure 4-2. Figure 4-5 shows how the plug-in jumper is installed on J201.

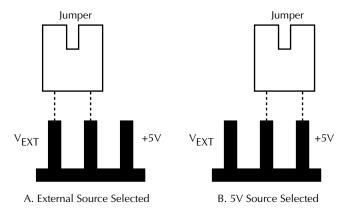


Figure 4-5
Voltage source jumper installation

#### **Pull-up resistors**

When interfacing outputs to high-impedance devices (i.e., logic devices), pull-up resistors are used to achieve the appropriate logic level. These resistors are installed at the factory.

#### Configuring digital I/O output logic

Referring to Figure 4-6 for the digital I/O output logic location, perform the following steps to configure J101:

- If mated together, separate the relay card from the connector card by removing the mounting screw and then pulling the two cards away from each other. Remember to only handle the cards by the edges and shields to avoid contamination.
- 2. Locate J101 on the relay board. Refer to Figure 4-6.
- 3. Determine if you require positive (high) or negative (low) logic.
- 4. Install the plug-in jumper in the appropriate position as shown in Figure 4-7.

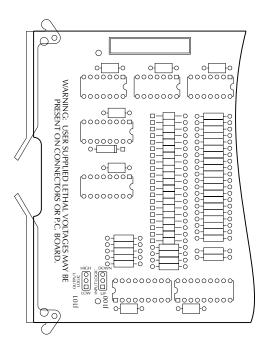
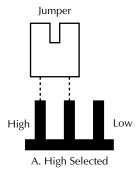


Figure 4-6
Digital I/O output logic location



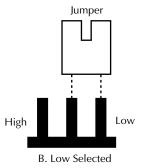
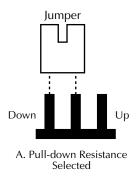


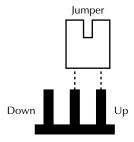
Figure 4-7
Digital I/O output logic selection

#### Configuring digital I/O input pull-up resistance

Referring to Figure 4-6 for digital I/O input pull-up resistance location, perform the following steps to configure J100:

- If mated together, separate the relay card from the connector card by removing the mounting screw and then pulling the two cards away from each other. Remember to only handle the cards by the edges and shields to avoid contamination.
- 2. Locate J100 on the relay board. Refer to Figure 4-6.
- 3. Determine if you require pull-up (5V) or pull-down (ground) input logic.
- 4. Install the plug-in jumper in the appropriate position as shown in Figure 4-8.





B. Pull-up Resistance Selected

Figure 4-8
Digital I/O input pull-up resistance selection

### Multi-pin (mass termination) connector card

Since connections to external circuitry are made at the 96-pin male DIN bulkhead connector, there is no need to separate the connector card from the relay card. If the connector card is separated from the relay card, carefully mate them together. Make sure to handle the cards by the edges and shields to avoid contamination.

Keithley has a variety of cable and connector accessories available to accommodate connections from the connector card to test instrumentation and DUTs (devices under test). In general, these accessories, which are summarized in Table 4-1, utilize a round cable assembly for connections.

Table 4-1
Mass termination accessories

| Model      | Description  |
|------------|--|
| 7011-KIT-R | 96-pin female DIN connector and housing for round cable (provided with the Model 7021 card). |
| 7011-MTC-2 | Two-meter round cable assembly terminated with a 96-pin female DIN connector on each end.    |
| 7011-MTR   | 96-pin male DIN bulkhead connector.  |

Terminal identification for the DIN connector of the multipin connector card is provided by Figure 4-9 and Table 4-2. This connector will mate to a 96-pin female DIN connector

Pins of the Model 7021 mass termination connector can be identified in one of three ways:

- Multiplex banks (A and B).
- Connector designation, consisting of rows a-c and columns 1-32.
- Schematic and component layout designation (1-96).

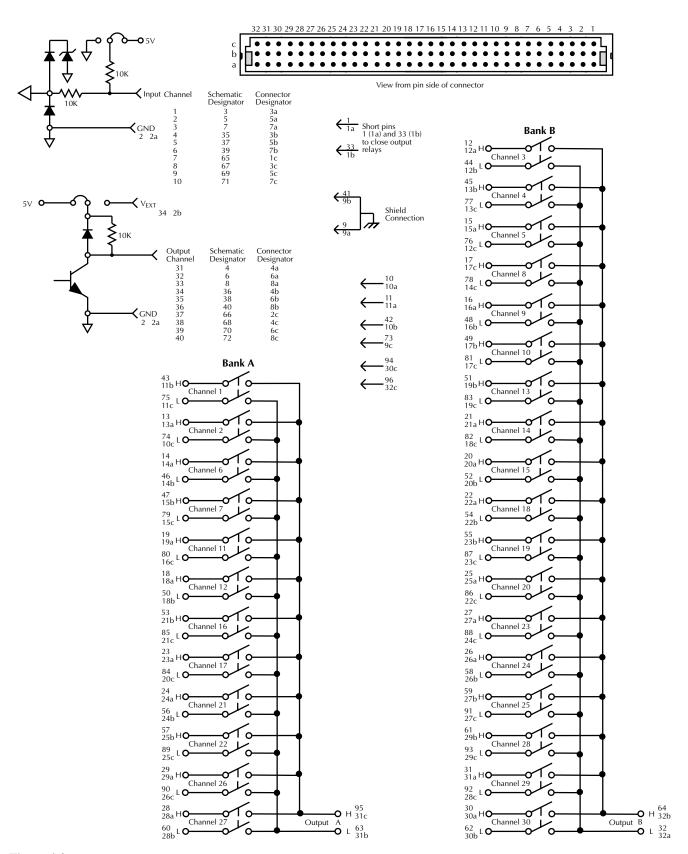


Figure 4-9
Multi-pin connector card terminal identification

Table 4-2
Pin designation identification

| Mux<br>terminal |             | Conn.<br>desig.<br>1a-32c | Schem.<br>desig.<br>1-96 | Mux<br>terminal |             | Conn.<br>desig.<br>1a-32c | Schem.<br>desig.<br>1-96 | Mux<br>terminal | Conn.<br>desig.<br>1a-32c | Schem. desig. 1-96 |
|-----------------|-------------|---------------------------|--------------------------|-----------------|-------------|---------------------------|--------------------------|-----------------|---------------------------|--------------------|
| Bank A          | Chan 1, HI  | 11b                       | 43                       | Bank A          | Chan 16, HI | 21b                       | 53                       | OUT A, HI       | 31c                       | 95                 |
|                 | Chan 1, LO  | 11c                       | 75                       |                 | Chan 16, LO | 21c                       | 85                       | OUT A, LO       | 31b                       | 63                 |
|                 | Chan 2, HI  | 13a                       | 13                       |                 | Chan 17, HI | 23a                       | 23                       | OUT B, HI       | 32b                       | 64                 |
|                 | Chan 2, LO  | 10c                       | 74                       |                 | Chan 17, LO | 20c                       | 84                       | OUT B, LO       | 32a                       | 32                 |
| Bank B          | Chan 3, HI  | 12a                       | 12                       | Bank B          | Chan 18, HI | 22a                       | 22                       | DIG OUT 31      | 4a                        | 4                  |
|                 | Chan 3, LO  | 12b                       | 44                       |                 | Chan 18, LO | 22b                       | 54                       | DIG OUT 32      | 6a                        | 6                  |
|                 | Chan 4, HI  | 13b                       | 45                       |                 | Chan 19, HI | 23b                       | 55                       | DIG OUT 33      | 8a                        | 8                  |
|                 | Chan 4, LO  | 13c                       | 77                       |                 | Chan 19, LO | 23c                       | 87                       | DIG OUT 34      | 4b                        | 36                 |
|                 | Chan 5, HI  | 15a                       | 15                       |                 | Chan 20, HI | 25a                       | 25                       | DIG OUT 35      | 6b                        | 38                 |
|                 | Chan 5, LO  | 12c                       | 76                       |                 | Chan 20, LO | 22c                       | 86                       | DIG OUT 36      | 8b                        | 40                 |
| Bank A          | Chan 6, HI  | 14a                       | 14                       | Bank A          | Chan 21, HI | 24a                       | 24                       | DIG OUT 37      | 2c                        | 66                 |
|                 | Chan 6, LO  | 14b                       | 46                       |                 | Chan 21, LO | 24b                       | 56                       | DIG OUT 38      | 4c                        | 68                 |
|                 | Chan 7, HI  | 15b                       | 47                       |                 | Chan 22, HI | 25b                       | 57                       | DIG OUT 39      | 6с                        | 70                 |
|                 | Chan 7, LO  | 15c                       | 79                       |                 | Chan 22, LO | 25c                       | 89                       | DIG OUT 40      | 8c                        | 72                 |
| Bank B          | Chan 8, HI  | 17a                       | 17                       | Bank B          | Chan 23, HI | 27a                       | 27                       | DIG IN 1        | 3a                        | 3                  |
|                 | Chan 8, LO  | 14c                       | 78                       |                 | Chan 23, LO | 24c                       | 88                       | DIG IN 2        | 5a                        | 5                  |
|                 | Chan 9, HI  | 16a                       | 16                       |                 | Chan 24, HI | 26a                       | 26                       | DIG IN 3        | 7a                        | 7                  |
|                 | Chan 9, LO  | 16b                       | 48                       |                 | Chan 24, LO | 26b                       | 58                       | DIG IN 4        | 3b                        | 35                 |
|                 | Chan 10, HI | 17b                       | 49                       |                 | Chan 25, HI | 27b                       | 59                       | DIG IN 5        | 5b                        | 37                 |
|                 | Chan 10, LO | 17c                       | 81                       |                 | Chan 25, LO | 27c                       | 91                       | DIG IN 6        | 7b                        | 39                 |
| Bank A          | Chan 11, HI | 19a                       | 19                       | Bank A          | Chan 26, HI | 29a                       | 29                       | DIG IN 7        | 1c                        | 65                 |
|                 | Chan 11, LO | 16c                       | 80                       |                 | Chan 26, LO | 26c                       | 90                       | DIG IN 8        | 3c                        | 67                 |
|                 | Chan 12, HI | 18a                       | 18                       |                 | Chan 27, HI | 28a                       | 28                       | DIG IN 9        | 5c                        | 69                 |
|                 | Chan 12, LO | 18b                       | 50                       |                 | Chan 27, LO | 28b                       | 60                       | DIG IN 10       | 7c                        | 71                 |
| Bank B          | Chan 13, HI | 19b                       | 51                       | Bank B          | Chan 28, HI | 29b                       | 61                       | nc              | 10a                       | 10                 |
|                 | Chan 13, LO | 19c                       | 83                       |                 | Chan 28, LO | 29c                       | 93                       | nc              | 11a                       | 11                 |
|                 | Chan 14, HI | 21a                       | 21                       |                 | Chan 29, HI | 31a                       | 31                       | nc              | 10b                       | 42                 |
|                 | Chan 14, LO | 18c                       | 82                       |                 | Chan 29, LO | 28c                       | 92                       | nc              | 9c                        | 73                 |
|                 | Chan 15, HI | 20a                       | 20                       |                 | Chan 30, HI | 30a                       | 30                       | nc              | 30c                       | 94                 |
|                 | Chan 15, LO | 20b                       | 52                       |                 | Chan 30, LO | 30b                       | 62                       | nc              | 32c                       | 96                 |
| Inter           |             | 1a                        | 1                        | Shield          |             | 9a                        | 9                        | Gnd             | 2a                        | 2                  |
| Inter           |             | 1b                        | 33                       | Shield          |             | 9b                        | 41                       | Vext            | 2b                        | 34                 |

#### Typical connection techniques

All external circuitry, such as instrumentation and DUTs, that you wish to connect to the card must be terminated with a single 96-pin female DIN connector. The following connection techniques provide some guidelines and suggestions for wiring your circuitry.

#### **WARNING**

Before beginning any wiring procedures, make sure all power is off and any stored energy in external circuitry is discharged.

#### WARNING

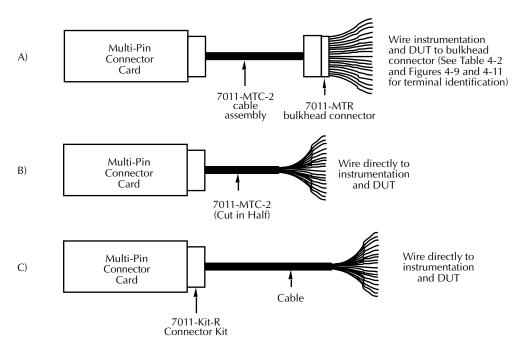
When wiring a connector or device under test, do not leave any exposed wires or connections. No conductive part of the circuit may be exposed. Properly cover the conductive parts, or death by electric shock may occur.

#### **NOTE**

It is recommended that external circuitry be connected (plugged in) after the Model 7021 is installed in the Model 7001/7002 mainframe and with the mainframe power off. Installation is covered at the end of this section.

Output relays — The multi-pin connector card uses a relay for each of the output banks. These output relays are normally open to prevent any hazardous voltages (via the mainframe backplane) from appearing on the pins of the male DIN connector. The output relays will only close when the Model 7011-MTC-2 cable assembly is connected to the card. If building your own cable assembly, you must make sure that it shorts pins 1a to 1b of the card connector (Figure 4-11) when it is mated to the card. Shorting pins 1a to 1b allows the output relays to close.

**Round cable assemblies** — Figure 4-10 shows typical round cable connection techniques using accessories available from Keithley.



**Notes:** Figure 4-12 provides an exploded view showing how the connector (with cable) is assembled.

Cable Hitachi p/n N2807-P/D-50TAB is a 50-conductor cable. Two of these cables can be used to supply 100 conductors.

Figure 4-10
Typical round cable connection techniques

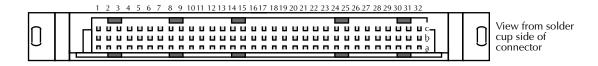


Figure 4-11
Model 7011-MTR connector pinout

In Figure 4-10A, connections are accomplished using a Model 7011-MTC-2 cable and a Model 7011-MTR bulkhead connector. The two-meter round cable is terminated with a 96-pin female DIN connector at each end. This cable mates directly to the multi-pin connector card and to the bulkhead connector. The bulkhead connector has solder cups to allow direct connection to instrumentation and DUT. Figure 4-11 provides pinout for the bulkhead connector. The view shown is from the solder cup end of the connector.

Note: See Figure 4-9 for terminal identification.

In Figure 4-10B, connections are accomplished using a Model 7011-MTC-2 cable assembly that is cut in half. The 96-pin female DIN connector on one end of the cable mates directly to the multi-pin connector card. The unterminated end of the cable is wired directly to instrumentation and DUT. The other half of the cable assembly could be used for a second switching card.

In Figure 4-10C, connections are accomplished using a custom-built cable assembly that consists of a Model 7011-KIT-R connector and a suitable round cable. Hitachi cable p/n N2807-P/D-50TAB is a 50-conductor round cable. Two of these cables can be used to provide 100 conductors. The connector has solder cups to accommodate the individual wires of the unterminated cable. Figure 4-12 provides an exploded view of the connector assembly and shows how the cable is connected. For further Model 7011-KIT-R assembly information, refer to the packing list provided with the kit. The connector end of the resultant cable assembly mates directly to the multi-pin connector card. The unterminated end of the cable assembly is wired directly to instrumentation and DUT.

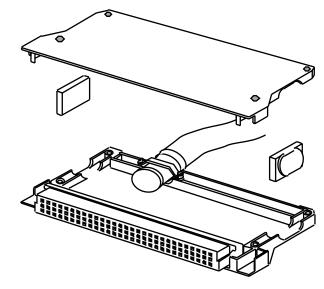


Figure 4-12
Model 7011-KIT-R (with cable) assembly

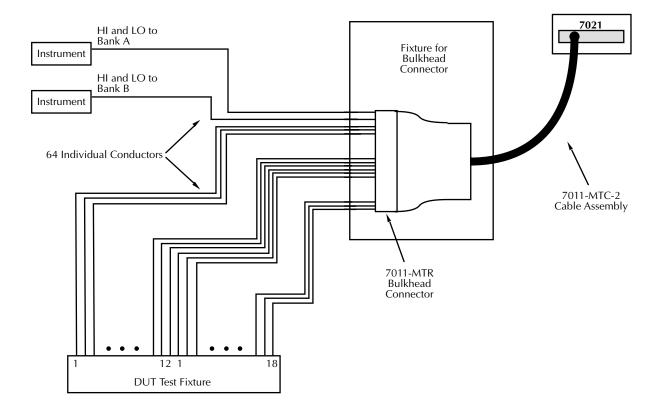
# **Typical multiplexer connection schemes**

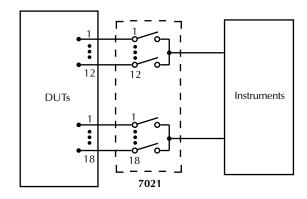
The following information provides some typical connection schemes for single-card, two-card, and two-mainframe system configurations. Connection schemes for the multi-pin connector card use some of the techniques presented in the Multiplexer connections paragraph. Keep in mind that these are only examples to demonstrate various ways to wire a test system. Connection details for the connector card are provided in the Multi-pin (mass termination) connector card paragraph.

# Single-card system

Figure 4-13 shows how external connections can be made to a single-card system that uses the multi-pin connector card. This single-card system is configured as dual  $1 \times 12$  and  $1 \times 18$  multiplex banks.

Instrumentation and DUTs are hard-wired to the Model 7011-MTR male bulkhead connector. This connector has solder cups that will accept wire size up to #24 AWG. The test system is connected to the multiplexer using the Model 7011-MTC-2 round cable assembly. This cable mates directly to both the external bulkhead connector and the Model 7021. Notice that the bulkhead connector is shown mounted to a fixture to help keep the cabling stable during the test.





Simplified Equivalent Circuit

Figure 4-13 Single-card system example

When using a single-card system, make sure that the card remains electrically isolated from any other switching cards. There are several ways to ensure isolation for a single card in the Model 7001/7002 mainframe:

- 1. Vacate the adjacent slot in the mainframe. If there is a Model 70XX card installed in the other slot, remove it.
- Remove the backplane jumpers on the card. This will disconnect the card from the analog backplane of the mainframe.
- 3. Remove the backplane jumpers from the switching card installed in the adjacent slot.

## **Two-card system**

Figure 4-14 shows a system using two Model 7021 cards installed in one Model 7001/7002 mainframe to configure a single  $1\times 60$  multiplexer system. Each card is configured as a single  $1\times 30$  multiplexer. To accomplish this, all bank-to-bank jumpers (both cards) are installed to connect banks A and B together. By leaving the backplane jumpers of both cards installed, the banks of card 1 are connected to the banks of card 2 through the analog backplane of the mainframe resulting in the  $1\times 60$  configuration.

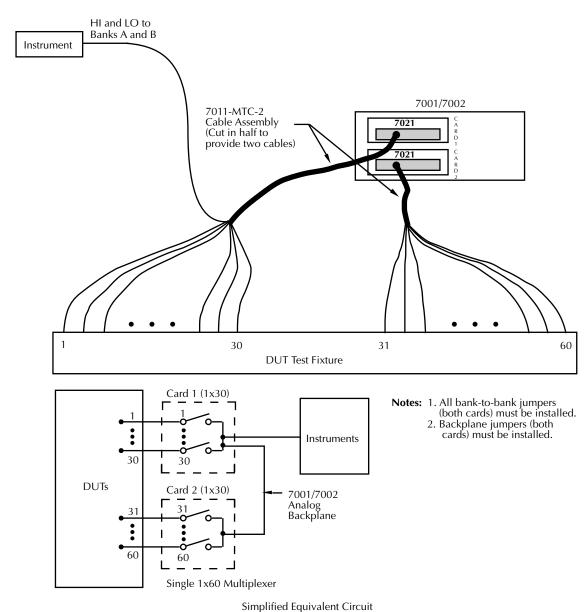


Figure 4-14
Two-card system example

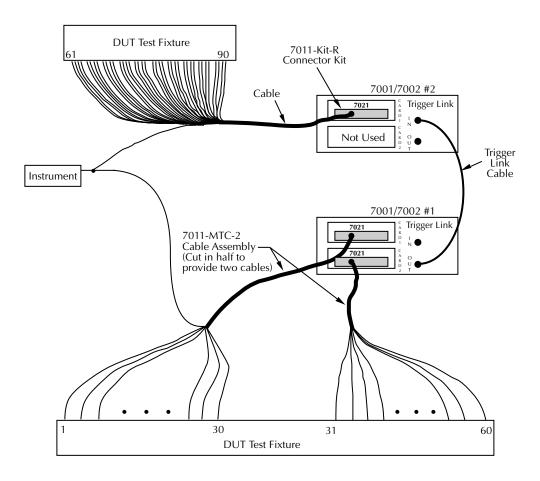
Figure 4-14 shows how external connections can be made for the multi-pin connector cards. In this example, a single Model 7011-MTC-2 round cable assembly is cut in half to provide two cables, each of which is unterminated at one end. The unterminated ends of the two cables are hard-wired to instrumentation and DUT as shown in the drawing. The other ends of these cables mate directly to the Model 7021 cards.

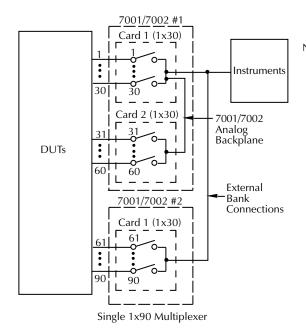
# **Two-mainframe system**

Figure 4-15 shows a system using three multiplexer cards installed in two Model 7001/7002 mainframes to configure a single  $1 \times 90$  multiplexer system. Each card is configured as a single  $1 \times 30$  multiplexer. To accomplish this, bank-to-bank jumpers of all three cards must be installed to connect banks A and B together.

By leaving the backplane jumpers of the cards in mainframe 1 installed, the banks of card 1 are connected to the banks of card 2 through the analog backplane of the Model 7001/7002 mainframe resulting in a  $1\times60$  configuration. External bank connections from the instrument to the card in the second mainframe connect the banks of all three cards together to form the  $1\times90$  multiplexer system. This system is similar to the two-card system (see previous paragraph) except that a third card (installed in a second mainframe) is added.

Figure 4-15 shows the connection scheme for the multi-pin connector cards. External circuit connections to the Model 7001/7002 mainframe 1 are identical to the ones used for the two-card system. The third card (installed in Model 7001/7002 mainframe 2) shows how a custom-built cable can be used to make connections to external circuitry. A suitable round cable can be terminated with a 96-pin female DIN connector (Model 7011-KIT-R) with two lengths of Hitachi cable P/N N2807-P/D-50TAB. This cable contains 50 conductors; two lengths provide 100 conductors. This cable will mate to the Model 7021. The unterminated end of the cable is connected directly to the instrumentation and DUT. Notice that the bank connections for the third card are made at the instruments.





Notes: 1. Backplane jumpers for both cards installed in 7001/7002 #1 must be installed.
2. All bank-to-bank jumpers, on all three cards, must be installed.

Simplified Equivalent Circuit

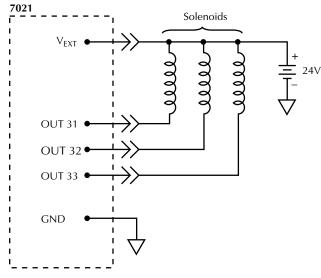
Figure 4-15
Two-mainframe system example

# Typical digital I/O connection schemes

# **Output connection schemes**

The following examples show output connections from the card to external circuitry and summarize the required internal connections on the card. Each example assumes negative true logic is used. To configure for positive true logic, refer to the Configuring digital I/O output logic paragraph.

Solenoid control — Figure 4-16 shows a digital output connection scheme to control solenoids. This example assumes that an external 24V source is being used. A solenoid is energized when the corresponding output channel is turned on (closed).



Internal connections:

External voltage source (V<sub>EXT</sub>) selected.

Figure 4-16
Digital output, solenoid control

Motor control — Figure 4-17 shows a digital output connection scheme to control small 12V dc motors. An external 12V source is used to provide the necessary voltage level. A motor is turned on when the corresponding output channel is turned on (closed).

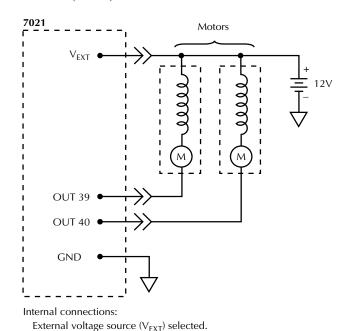


Figure 4-17
Digital output, motor control

Logic device control — Figure 4-18 shows a digital output connection scheme to control a logic device. This example assumes that an internal +5V voltage source is being used.

The logic device is a demultiplexer (DMUX). The binary pattern (value) seen at the input of the DMUX (lines A, B, and C) determines which DMUX output line (Y0 through Y7) is selected (pulled low). For example, with channels 31, 32, and 33 off (open), lines A, B and C are high. The binary 7 at the DMUX input (A = 1, B = 1 and C = 1) selects (pulls low) output Y7. If channel 32 is turned on (closed), line B goes low. The binary 5 seen at the DMUX input (1, 0, 1) selects (pulls low) Y5.

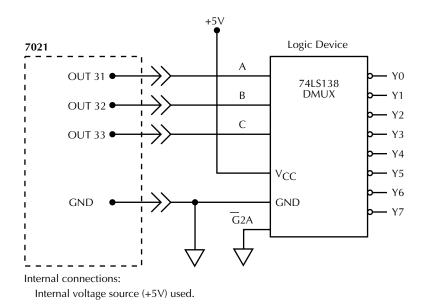


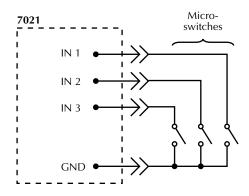
Figure 4-18
Digital output, logic device control

# Input connection scheme

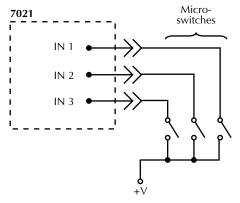
Figure 4-19 shows a digital input connection scheme to monitor the state of micro-switches. With a switch open and the input resistor configured for pull up, as shown in Figure 4-19A, the corresponding input channel is pulled high by the internal input resistor. As a result, the input channel is high (appears as a bar on the Model 7001 display or a lit LED on the Model 7002). When a switch is closed, the corresponding input channel is pulled low to ground. As a result, the input channel is low (appears as a single dot on the Model 7001 display or an unlit LED on the Model 7002).

With a switch open and the input resistance configuration set to pull down, as shown in Figure 4-19B, the corresponding input channel is pulled low by the internal input resistor. As a result, the input channel is low. When a switch is closed, the corresponding input channel is pulled high. As a result, the input channel is high.

For more information on configuring pull-up resistance, refer to the Configuring digital I/O input pull-up resistance paragraph.



A. Input resistor is set to pull up.



B. Input resistor is set to pull down.

# Figure 4-19 Digital input, monitoring micro-switches

## Model 7021 installation and removal

This following paragraphs explain how to install and remove the Model 7021 card from the Model 7001/7002 mainframe.

#### WARNING

Installation or removal of the Model 7021 is to be performed by qualified service personnel. Failure to recognize and observe standard safety precautions could result in personal injury or death.

#### **CAUTION**

To prevent contamination to the multiplexer card that could degrade performance, only handle the card by the edges and shields.

## **Card installation**

Perform the following steps to install the Model 7021 card in the Model 7001/7002 mainframe:

#### WARNING

Turn off power from all instrumentation (including the Model 7001/7002 mainframe) and disconnect their line cords. Make sure all power is removed and

stored energy in external circuitry is discharged.

- 1. Mate the connector card to the relay card if they are separated. Install the supplied 4-40 screw at the end of the card to secure the assembly. Make sure to handle the cards by the edges and shields to prevent contamination.
- 2. Facing the rear panel of the mainframe, select the slot (CARD 1 or CARD 2) that you wish to install the Model 7021 card in.
- 3. Referring to Figure 4-20, feed the Model 7021 card into the desired slot so the edges of the relay card ride in the rails.
- 4. With the ejector arms in the unlocked position, push the Model 7021 card all the way into the mainframe until the arms engage into the ejector cups. Then push both arms inward to lock the card into the mainframe.

#### **WARNING**

To avoid electric shock that could result in injury or death, make sure to properly install and tighten the safety ground screw shown in Figure 4-20.

5. Install the screw shown in Figure 4-20.

## Card removal

To remove the Model 7021 card, first unloosen the safety ground screw, unlock the card by pulling the latches outward, and then pull the card out of the mainframe. Remem-

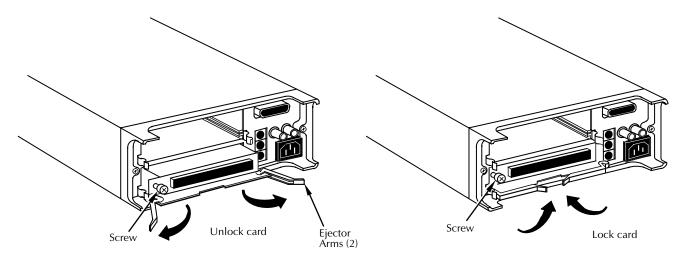


Figure 4-20 Model 7021 card installation in Model 7001

ber to handle the card by the edges and shields to avoid contamination that could degrade performance.

# 5 Operation

## Introduction

The information in this section is formatted as follows:

- **Power limits** Summarizes the maximum power limits of the Model 7021 multiplexer-digital I/O card.
- Mainframe control of the card Summarizes programming steps to control the card from the Model 7001/7002 switch system mainframe.
- **Multiplexer switching examples** Provides some typical applications for using the Model 7021.
- Measurement considerations Reviews a number of considerations when using the Model 7021 to make measurements.

## **Power limits**

#### **CAUTION**

To prevent damage to the card, do not exceed the maximum signal level specifications of the card.

# **Analog multiplexer maximum signal levels**

To prevent overheating or damage to the relays, never exceed the following maximum signal levels: 110V DC or rms, 155V peak between any two inputs or chassis, 1A switched, 30VA (resistive load).

# Digital I/O maximum signal levels

To ensure proper operation and prevent damage to the card, never exceed the following power limits:

## Output channels

Maximum user-supplied pull-up voltage: 42V Maximum sink current:

Per channel: 250mA Per card: 1A

#### Input channels

Maximum voltage level: 42V peak

## Mainframe control of the card

The following information pertains to the Model 7021. It assumes that you are familiar with the operation of the Model 7001/7002 mainframe—whichever is used.

If you are not familiar with the operation of the mainframe in use, proceed to Getting Started (Section 3) of the Model 7001 or Model 7002 Instruction Manual after reading the following information.

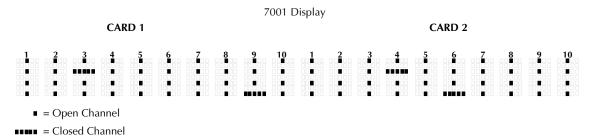


Figure 5-1
Model 7001 channel status display

# **Channel assignments**

The Model 7001 has a channel status display (Figure 5-1) that provides the real-time state of each available channel. The left portion of the display is for slot 1 (Card 1), and the right portion is for slot 2 (Card 2). For the Model 7002, channel status LED grids are used for the ten slots. The LED grid for slot 1 is shown in Figure 5-2.

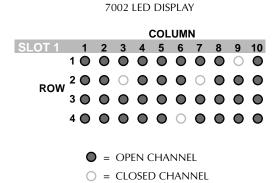


Figure 5-2 Model 7002 channel status display (slot 1)

Organization of the channel status display for each slot is shown in Figure 5-3. The card contains 40 channels and is made up of two multiplex banks (Bank A and B) totaling 30 channels and ten digital output channels as shown in the illustration.

The multiplex banks can be jumpered to the backplane of the mainframe to expand multiplexer inputs.

All digital input and output channels are isolated from the backplane of the mainframe. With the mainframe in the normal display state, the status (on or off) of the output channels is displayed. When the mainframe is in the read input channels mode, the status (on or off) of the input channels is displayed.

The hardware for the digital output channels is user configurable for negative or positive true logic. That is, depending on the user configuration, the output can go high or be pulled low when the channel is turned on (closed) or off (open). To configure output logic, refer to Section 4.

Input channels use positive true logic but can be configured to pull up or pull down. Thus, a channel can be pulled high or pulled low when the input is open depending on the jumper configuration. Input channels will be displayed as high (on) when the input has a high logic level applied. Conversely, an input channel will be displayed as low (off) when a low logic level is applied.

To control the card from the mainframe, each multiplexer input and digital output must have a unique channel assignment. The channel assignments for the card are provided in Figure 5-4. Each channel assignment is made up of the slot designator (1 or 2) and the channel (1 to 40). For the Model 7002, the slot designator can be from 1 to 10 since there are 10 slots. To be consistent with Model 7001/7002 operation, the slot designator and channel are separated by an exclamation point (!). Some examples of channel assignments are as follows:

CHANNEL 1!1 = Slot 1, Channel 1 (Input 1 of Bank A)
CHANNEL 1!40 = Slot 1, Channel 40 (Output 40 of Digital I/O)

CHANNEL 2!23 = Slot 2, Channel 23 (Input 13 of Bank B) CHANNEL 2!36 = Slot 2, Channel 36 (Output 36 of Digital I/O)

These channels are displayed and controlled from the normal display state of the mainframe. If currently in the menu structure, return to the normal display state by pressing EXIT.

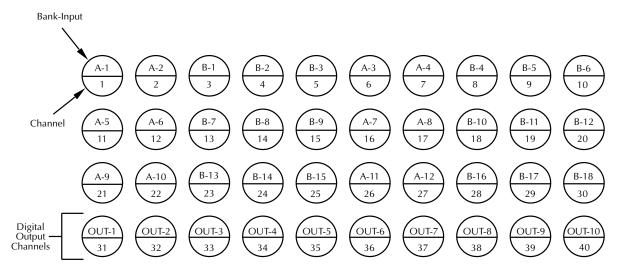
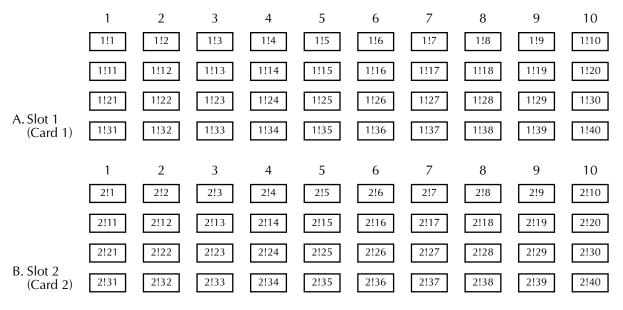


Figure 5-3
Display organization for multiplexer channels



Examples: 1!18 = Slot 1, Channel 18 (Input 10, Bank B) 2!36 = Slot 2, Channel 36 (Output 36, Digital I/O)

Figure 5-4
Model 7021 programming channel assignments

# Closing and opening channels

#### NOTE

This procedure applies to multiplexer channels (channels 1!1 through 1!30) and digital output channels (1!31 through 1!40). Digital input channels are read only.

A channel is turned on (closed) by keying in the channel assignment and pressing CLOSE. For example, to turn on (close) channel 36 (Output 36 of Digital I/O) of a card installed in slot 2, key in the following channel list and press CLOSE:

#### **SELECT CHANNELS 2!36**

The above closed channel can be turned off (opened) by pressing OPEN or OPEN ALL. The OPEN key turns off (opens) only the channels specified in the channel list, and OPEN ALL turns off (opens) all channels.

#### NOTE

For the Model 7002 mainframe, you can use the light pen to turn output channels on and off.

The following display is an example of a channel list that consists of several channels:

## SELECT CHANNELS 2!1, 2!3, 2!22-2!25

Notice that channel entries are separated by commas (,). A comma is inserted by pressing ENTER or the right cursor key ( ). The channel range is specified by using the hyphen (-) key to separate the range limits. Pressing CLOSE will close all the channels specified in the channel list. Pressing OPEN (or OPEN ALL) will open the channels.

Channel patterns can also be used in a channel list. This allows you to control specific bit patterns for logic circuits. Example:

#### SELECT CHANNELS 2!1, M1

Pressing CLOSE will turn on channel 2!1 and the channels that make up channel pattern M1. Refer to the mainframe instruction manual for information on defining channel patterns.

# **Scanning channels**

Channels are scanned by creating a scan list and configuring the Model 7001/7002 to perform a scan. The scan list is created in the same manner as a channel list (See the Closing and opening channels paragraph). However, the scan list is specified from the SCAN CHANNELS display mode. (The SCAN LIST key toggles between the channel list and the scan list.) The following shows an example of a scan list:

#### SCAN CHANNELS 2!1, 2!3, 2!21-2!25

When a scan is performed, the channels specified in the scan list will be scanned in the order that they are presented in the scan list.

Channel patterns can also be used in a scan list. This allows you to control specific bit channels or bit patterns. For example:

### SCAN CHANNELS M1, M2, M3, M4

When M1 is scanned, the channels that make up channel pattern M1 will turn on. When M2 is scanned, the M1 channels will turn off and the channels that make up M2 will turn on. M3 and M4 are scanned in a similar manner. Refer to the instruction manual for the mainframe for information on defining channel patterns.

A manual scan can be performed by using the RESET default conditions of the Model 7001/7002. RESET is selected from the SAVESETUP menu of the main MENU. When RESET is performed, the mainframe is configured for an infinite number of manual scans. The first press of STEP takes the mainframe out of the idle state. The next press of STEP will close the first channel specified in the scan list. Each subsequent press of STEP will select the next channel in the scan list.

# Reading input channels

Input channels are read from the READ-I/O-CARD option of the CARD CONFIG MENU of the mainframe. This menu is accessed by pressing the CARD key. In this "read input channels" display mode, the mainframe displays the real-time state of each input channel.

Input channels use positive true logic but can be configured to pull up or pull down. Open inputs will read high (on) if inputs are configured for pull up. Conversely, open inputs will read low (off) when configured for pull down. To configure pull-up resistance, refer to Section 4.

Perform the following steps to configure the mainframe to display the digital input channels.

- 1. Press the CARD CONFIGURATION key to display the CARD CONFIG MENU.
- 2. Use the ◀ and ▶ keys to place the cursor on READ-I/O-CARD and press ENTER.

Model 7001 mainframe — The real-time state (on or off) of each input channel is provided on the first row of the display. Only digital I/O input channels are displayed.

Model 7002 mainframe — The real-time state (on or off) of each input channel is provided on the first row of the appropriate LED display grid. Use the TYPE option of the CARD CONFIG MENU if you do not know which slot the card is installed in.

3. Use the EXIT key to exit from the "read input channels" display mode.

#### NOTE

With input channels displayed, you can turn off (open) all other channels by pressing OPEN ALL.

## **IEEE-488** bus operation

Bus operation is demonstrated using Microsoft QuickBASIC 4.5, the Keithley KPC-488.2 (or Capital Equipment Corporation) IEEE interface and the HP-style Universal Language Driver (CECHP). Refer to "QuickBASIC 4.5 Programming" in the mainframe manual for details on installing the Universal Language Driver, opening driver files and setting the input terminal. Program statements assume that the primary address of the mainframe is 07.

## Turning channels on and off

The following SCPI commands are used to turn multiplexer and digital I/O output channels on and off:

```
:CLOSe :CLOSe :CLOSe :OPEN :ALL Turn off specified (or all) channels.
```

The following program statement turns on channels 1!1, 1!4 through 1!6, and the channels that make up channel pattern M1.

```
PRINT #1, "output 07; clos (@ 1!1, 1!4:1!6, M1)"
```

Notice that the colon (:) is used to separate the range limits.

Either of the following statements turns off channels 1!1, 1!4 through 1!6, and the channels of M1:

```
PRINT #1, "output 07; open (@ 1!1, 1!4:1!6, M1)" PRINT #1, "output 07; open all"
```

### Scanning output channels

There are many commands associated with scanning. However, it is possible to configure a scan using as little as four commands. These commands are listed as follows:

```
*RST
:TRIGger:COUNT:AUTO ON
:ROUTe:SCAN <list>
:INIT
```

The first command resets the mainframe to a default scan configuration. The second command automatically sets the channel count to the number of channels in the scan list, the third command defines the scan list, and the fourth command takes the Model 7001/7002 out of the idle state.

The following program fragment will perform a single scan of channels 1 through 4 of slot 1 and the channels that make up channel pattern M1:

```
PRINT #1, "output 07; *rst"

PRINT #1, "output 07; trig:coun:auto on"

PRINT #1, "output 07; scan (@ 1!1:1!4, M1)"

PRINT #1, "output 07; init"
```

The first statement selects the \*RST default configuration for the scan. The second statement sets channel count to the scan-list-length (5). The third statement defines the scan list, and the last statement takes the mainframe out of the idle state. The scan is configured to start as soon as the :INIT command is executed.

When the above program fragment is run, the scan will be completed in approximately 240 milliseconds (3msec delay for channel closures and 3msec delay for each open), which is too fast to view from the front panel. An additional relay delay can be added to the program to slow down the scan for viewing. The program is modified by adding a statement to slow down the scan. Also, a statement is added to the beginning of the program to ensure that all channels are open before the scan is started. The two additional statements are indicated in bold typeface.

```
PRINT #1, "output 07; open all"
PRINT #1, "output 07; *rst"
PRINT #1, "output 07; trig:coun:auto on"
PRINT #1, "output 07; trig:del 0.5"
PRINT #1, "output 07; scan (@ 1!1:1!4, M1)"
PRINT #1, "output 07; init"
```

The first statement opens all channels, and the fourth statement sets a 1/2 second delay after each channel closes.

## Reading digital I/O input channels

The following SCPI commands are used to read the status of digital I/O input channels:

```
:SENSe2:DATA? <list>
                            Read input channels; slot 1
                            Read input channels; slot 2
:SENSe3:DATA? <list>
:SENSe4:DATA? <list>
                            Read input channels; slot 3
:SENSe5:DATA? <list>
                            Read input channels; slot 4
:SENSe6:DATA? <list>
                            Read input channels; slot 5
:SENSe7:DATA? <list>
                            Read input channels; slot 6
:SENSe8:DATA? <list>
                            Read input channels; slot 7
:SENSe9:DATA? <list>
                            Read input channels; slot 8
                            Read input channels; slot 9
:SENSe10:DATA? <list>
:SENSell:DATA? <list>
                            Read input channels; slot 10
```

The conventional form for the list> parameter includes the slot and input channel number. However, for these commands you do not need to include the slot number. For example, you can send either of the following two commands to read input channel 2 in slot 6:

```
:SENSe7:DATA? (@6!2) or :SENSe7:DATA? (@2)
```

After the mainframe is addressed to talk, the response message will indicate the state of each listed input channel. A returned "0" indicates that the channel is off (open), and a returned "1" indicates that the channel is on (closed).

The following program fragment reads channel 3 of a digital I/O card installed in slot 1:

```
PRINT #1, "output 07; sens2:data? (@3)"
PRINT #1, "enter 07"
LINE INPUT #2, A$
PRINT A$
```

The first statement reads input channel 3 (slot 1). The second statement addresses the mainframe to talk (sends response message to computer). The third statement reads the response message, and the last statement displays the message (0 or 1) on the computer CRT.

The above program fragment is modified to read all 10 digital I/O input channels in slot 1 as follows. The modified statement is shown in bold typeface.

```
PRINT #1, "output 07; sens2:data? (@1:10)"
PRINT #1, "enter 07"
LINE INPUT #2, A$
PRINT A$
```

The response message will include a "0" (off) or "1" (on) for each of the 10 input channels (i.e., "0, 0, 0, 1, 0..... 0, 1").

# Multiplexer switching examples

This paragraph presents some typical applications for the Model 7021. These include resistor testing and transistor testing. It also shows how to use the Model 7021 with a matrix-digital I/O card (Model 7022).

# Resistor testing

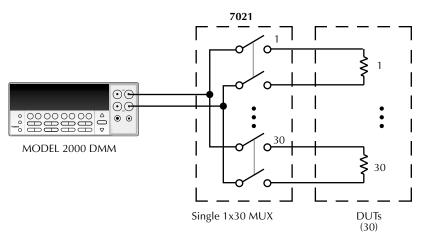
The Model 7021 can be used to test a large number of resistors using only one test instrument or group of instruments. Such tests include two-wire and four-wire resistance measurements using a DMM and low-resistance measurements using a current source and sensitive digital voltmeter, as discussed in the following paragraphs.

#### Two-wire resistance tests

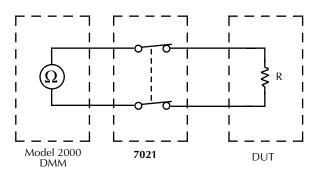
Figure 5-5 shows a typical test setup for making two-wire resistance measurements. The Model 7021 provides the switching function, while the resistance measurements are made by a Model 2000 DMM. Since only two-pole switching is required for this application, one Model 7021 card can be used to switch up to 30 resistors (additional multiplex banks can be added, if desired, by adding more cards).

Accuracy of measurements can be optimized by minimizing stray resistance.

Make connecting wires as short as possible to minimize path resistance. Another technique is to short one of the multiplexer inputs, close the shorted channel, and then enable the DMM zero feature to cancel path resistance. Leave zero enabled for the entire test.



A. Test Configuration



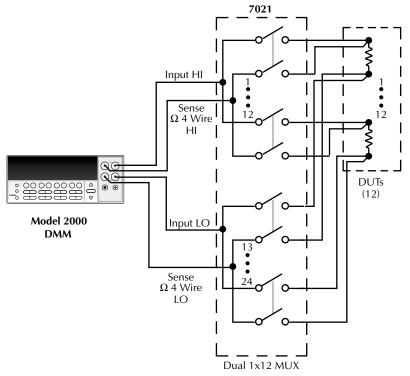
B. Simplified Equivalent Circuit

Figure 5-5
Two-wire resistance testing

## Four-wire resistance tests

More precise measurements over a wider range of system and DUT conditions can be obtained by using the four-wire measurement scheme shown in Figure 5-6. Here, separate sense leads from the Model 2000 DMM are routed through the multiplexer to the resistor under test. The extra set of sense

leads minimizes the effects of voltage drops across the test leads. Note, however, that an extra two poles of switching are required for each resistor tested. For this reason, only 12 resistors per card can be tested using this configuration because two channels must close at the same time.



A. Test Configuration

**Note:** Jumpers between Banks A and B are removed.

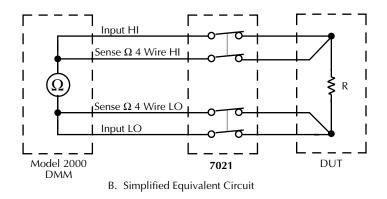


Figure 5-6
Four-wire resistance testing

Although the four-wire connection scheme minimizes problems caused by voltage drops, there is one other potentially troublesome area associated with low resistance measurements: thermal EMFs caused by the relay contacts. In order to compensate for thermal EMFs, the offset-compensated ohms feature of the Model 2000 DMM should be used.

 Table 5-1

 Paired channels in four-wire resistance example

| Device<br>under test | Channel pair | Connection designations            |
|----------------------|--------------|------------------------------------|
| 1                    | 1 and 3      | Bank A, In 1 and<br>Bank B, In 3   |
| 2                    | 2 and 4      | Bank A, In 2 and<br>Bank B, In 4   |
| 3                    | 6 and 5      | Bank A, In 6 and<br>Bank B, In 5   |
| 4                    | 7 and 8      | Bank A, In 7 and<br>Bank B, In 8   |
| 5                    | 11 and 9     | Bank A, In 11 and<br>Bank B, In 9  |
| 6                    | 12 and 10    | Bank A, In 12 and<br>Bank B, In 10 |
| 7                    | 16 and 13    | Bank A, In 16 and<br>Bank B, In 13 |
| 8                    | 17 and 14    | Bank A, In 17 and<br>Bank B, In 14 |
| 9                    | 21 and 15    | Bank A, In 21 and<br>Bank B, In 15 |
| 10                   | 22 and 18    | Bank A, In 22 and<br>Bank B, In 18 |
| 11                   | 26 and 19    | Bank A, In 26 and<br>Bank B, In 19 |
| 12                   | 27 and 20    | Bank A, In 27and<br>Bank B, In 20  |

#### Low-level resistance measurements

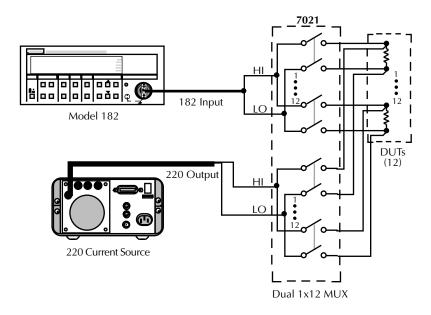
Many times, it is necessary to make resistance measurements with either lower voltage sensitivity or higher currents than are available with ordinary DMMs. Examples of cases where low-level resistance measurements may be necessary include the testing of PC board traces, contacts, bus bars, and low resistance shunts.

Figure 5-7 shows a typical test configuration for a switching system capable of testing a number of low resistance devices. The Model 220 Current Source forces current through the device under test, while the Model 182 Sensitive Digital Voltmeter measures the resulting voltage across the device.

Since low voltage levels are being measured, thermal EMF offsets generated by relay and connector contacts will have a detrimental effect on measurement accuracy unless steps are taken to avoid them. (The Model 7021 has been designed to keep relay EMF at a minimal level.) Thermal EMF effects can be virtually eliminated by taking two voltage measurements,  $E_1$  and  $E_2$ , the first with the current, I, flowing in one direction, and the second with a current, I, of the same magnitude, flowing in the opposite direction. The resistance can then be calculated as follows:

$$R = \frac{E_2 - E_1}{2I}$$

Note that reversing the current source polarity will result in a 2× accuracy specification change. To avoid this problem, matrix switching could be added to the test system to reverse the current. See Section 4.



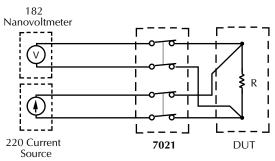


Figure 5-7
Low resistance testing

# **Transistor testing**

Typical transistor tests that can be performed with the aid of the Model 7021 include current gain tests, leakage tests, as well as tests to determine the common-emitter characteristics of the device. The following paragraphs discuss these tests and give typical equipment configurations for the tests.

## Current gain tests

The DC or static common-emitter current gain of a transistor can be determined by biasing the transistor for a specific value of base current,  $I_B$ , and then measuring the collector current,  $I_C$ . The DC common-emitter current gain,  $\beta$ , of the transistor is then determined as follows:

$$\beta = \frac{I_C}{I_B}$$

Figure 5-8 shows the test configuration and equivalent circuit for the current gain test. The Model 224 Current Source is used to source the base current,  $I_{\rm B}$ . The Model 230 Voltage Source supplies the collector-emitter voltage,  $V_{\rm CE}$ , and the collector current,  $I_{\rm C}$ , is measured by the Model 2000 DMM. Switching among the transistors being tested is performed by the Model 7021.

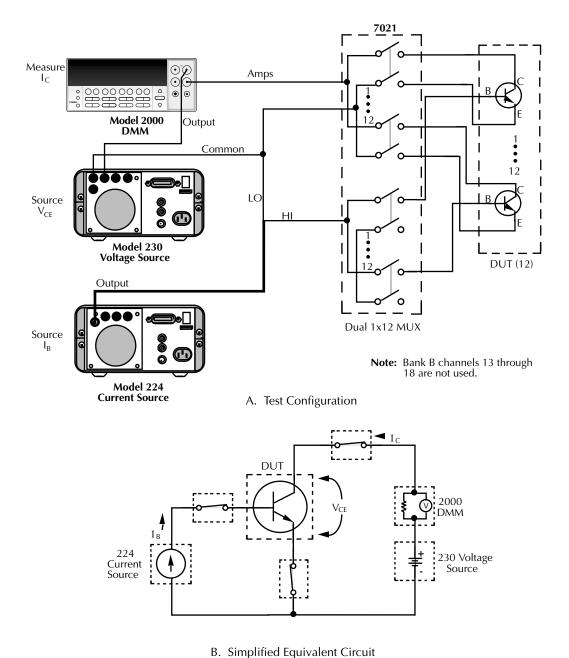


Figure 5-8

In order to perform the current gain test, the voltage source is first set to the desired value of  $V_{CE}$ . The current source is then set to a base current value that will result in the desired value of  $I_{C}$  as measured by the DMM. The current gain can

then be calculated as outlined in the previous paragraph.

Configuration for current gain and common-emitter test

In order to reduce errors caused by voltage burden, use a higher current range on the Model 2000 DMM. Doing so will result in the loss of one or two decades of resolution, but 3 1/2 or 4 1/2-digit resolution will probably be adequate for most situations.

#### Common-emitter characteristic tests

Common-emitter characteristics are determined by setting the base current,  $I_B$ , to specific values. At each  $I_B$  value, the collector-emitter voltage,  $V_{CE}$ , is swept across the desired range at specific intervals, and the collector current,  $I_C$ , is then measured. When the data results are plotted, the result is the familiar family of common-emitter curves (Figure 5-9).

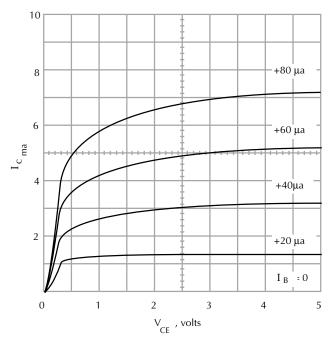


Figure 5-9
Typical common-emitter characteristics

The same test configuration used for current gain tests can be used for measuring common-emitter characteristics. The Model 224 is used to set the base current,  $I_B$ , to the desired values. The Model 230 Voltage Source provides the collector-emitter voltage,  $V_{CE}$ , and the Model 2000 DMM measures the collector current,  $I_C$ .

# **Testing with matrix-digital I/O cards**

The Model 7021 can be added to a matrix switching system to enhance the test capabilities of that system. The following paragraphs discuss an overall multiplexer/matrix switching system and also briefly outline a typical test that can be made with such a system.

## Multiplexer and matrix card connections

Figure 5-10 shows a typical system using Model 7022 and 7021 cards together. In this instance, the multiplexer-digital I/O card is configured as dual  $1 \times 12$  and  $1 \times 18$  multiplexers. Note that the rows of the matrix-digital I/O card are connected to the banks of the multiplexer-digital I/O card through the analog backplane of the mainframe; no external wiring is necessary to connect the two cards together.

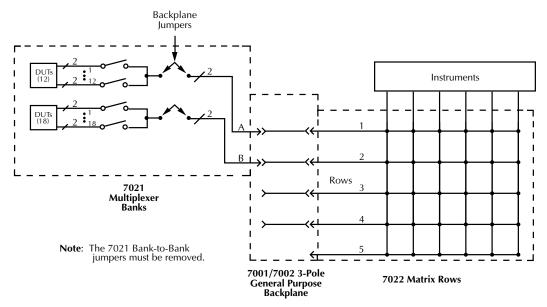


Figure 5-10
Connecting model 7021 and model 7022 cards together

In this application, the DUTs are connected to the bank inputs on the multiplexer and allow a large number of DUTs to be switched through the matrix-digital I/O card. Also, the instruments are connected to the columns on the matrix-digital I/O card. This particular configuration is best suited for applications requiring a large number of DUTs to be connected to several instruments. In other cases, the test configuration may call for a large number of instruments and few DUTs. In those situations, the instruments would be connected to the multiplexer inputs, and the DUTs would be connected to the columns.

## **Measurement considerations**

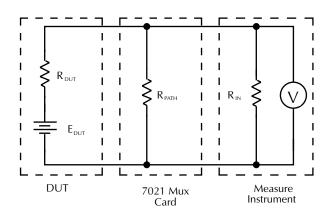
Many measurements made with the Model 7021 are subject to various effects that can seriously affect low-level measurement accuracy. The following paragraphs discuss these effects and ways to minimize them.

#### Path isolation

The path isolation is simply the equivalent impedance between any two test paths in a measurement system. Ideally, the path isolation should be infinite, but the actual resistance and distributed capacitance of cables and connectors results in less than infinite path isolation values for these devices.

Path isolation resistance forms a signal path that is in parallel with the equivalent resistance of the DUT, as shown in Figure 5-11. For low-to-medium device resistance values, path isolation resistance is seldom a consideration; however, it can seriously degrade measurement accuracy when testing high-impedance devices. The voltage measured across such a device, for example, can be substantially attenuated by the voltage divider action of the device source resistance and path isolation resistance, as shown in Figure 5-12. Also, leakage currents can be generated through these resistances by voltage sources in the system.

Any differential isolation capacitance affects DC measurement settling time as well as AC measurement accuracy. Thus, it is often important that such capacitance be kept as low as possible. Although the distributed capacitance of the multiplexer-digital I/O card is generally fixed by design, there is one area where you do have control over the capacitance in your system: the connecting cables. To minimize capacitance, keep all cables as short as possible.



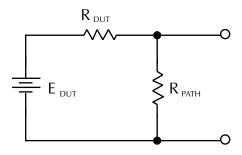
 $R_{\text{DUT}}$  = Source Resistance of DUT

 $E_{DUT}$  = Source EMF of DUT

R<sub>PATH</sub> = Path Isolation Resistance

 $R_{IN}$  = Input Resistance of Measuring Instrument

Figure 5-11
Path isolation resistance



$$E_{OUT} = \frac{E_{DUT} R_{PATH}}{R_{DUT} + R_{PATH}}$$

Figure 5-12
Voltage attenuation by path isolation resistance

# **Magnetic fields**

When a conductor cuts through magnetic lines of force, a very small current is generated. This phenomenon will frequently cause unwanted signals to occur in the test leads of a switching multiplexer system. If the conductor has sufficient length, even weak magnetic fields like those of the earth can create sufficient signals to affect low-level measurements.

Two ways to reduce these effects are: (1) reduce the lengths of the test leads, and (2) minimize the exposed circuit area. In extreme cases, magnetic shielding may be required. Special metal with high permeability at low flux densities (such as mu metal) is effective at reducing these effects.

Even when the conductor is stationary, magnetically induced signals may still be a problem. Fields can be produced by various signals such as the AC power line voltage. Large inductors such as power transformers can generate substantial magnetic fields, so care must be taken to keep the switching and measuring circuits a good distance away from these potential noise sources.

At high current levels, even a single conductor can generate significant fields. These effects can be minimized by using twisted pairs, which will cancel out most of the resulting fields.

# Radio frequency interference

Radio Frequency Interference (RFI) is a general term used to describe electromagnetic interference over a wide range of frequencies across the spectrum. Such RFI can be particularly troublesome at low signal levels, but it can also affect measurements at high levels if the problem is of sufficient severity.

RFI can be caused by steady-state sources such as radio or TV signals or some types of electronic equipment (microprocessors, high speed digital circuits, etc.), or it can result from impulse sources, as in the case of arcing in high-voltage environments. In either case, the effect on the measurement can be considerable if enough of the unwanted signal is present.

RFI can be minimized in several ways. The most obvious method is to keep the equipment and signal leads as far away from the RFI source as possible. Shielding the switching card, signal leads, sources, and measuring instruments will often reduce RFI to an acceptable level. In extreme cases, a specially constructed screen room may be required to sufficiently attenuate the troublesome signal.

Many instruments incorporate internal filtering that may help to reduce RFI effects in some situations. In some cases, additional external filtering may also be required. Keep in mind, however, that filtering may have detrimental effects on the desired signal.

# **Ground loops**

When two or more instruments are connected together, care must be taken to avoid unwanted signals caused by ground loops. Ground loops usually occur when sensitive instrumentation is connected to other instrumentation with more than one signal return path such as power line ground. As shown in Figure 5-13, the resulting ground loop causes current to flow through the instrument LO signal leads and then back through power line ground. This circulating current develops a small but undesirable voltage between the LO terminals of the two instruments. This voltage will be added to the source voltage, affecting the accuracy of the measurement.

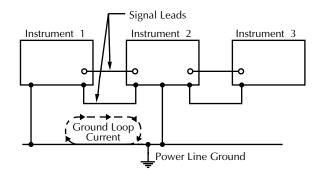


Figure 5-13
Power line ground loops

Figure 5-14 shows how to connect several instruments together to eliminate this type of ground loop problem. Here, only one instrument is connected to power line ground.

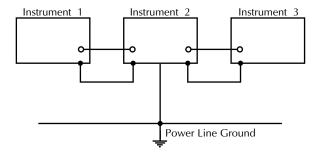


Figure 5-14
Eliminating ground loops

Ground loops are not normally a problem with instruments having isolated LO terminals. However, all instruments in the test setup may not be designed in this manner. When in doubt, consult the manual for all instrumentation in the test setup.

## **Keeping connectors clean**

As is the case with any high-resistance device, the integrity of connectors can be damaged if they are not handled properly. If connector insulation becomes contaminated, the insulation resistance will be substantially reduced, affecting high-impedance measurement paths.

Oils and salts from the skin can contaminate connector insulators, reducing their resistance. Also, contaminants present in the air can be deposited on the insulator surface. To avoid these problems, never touch the connector insulating material. In addition, the multiplexer-digital I/O card should be used only in clean, dry environments to avoid contamination.

If the connector insulators should become contaminated, either by inadvertent touching, or from airborne deposits, they can be cleaned with a cotton swab dipped in clean methanol. After thoroughly cleaning, they should be allowed to dry for several hours in a low-humidity environment before use, or they can be dried more quickly using dry nitrogen.

# **AC** frequency response

The AC frequency response of the Model 7021 is important in test systems that switch AC signals. Refer to the specifications at the front of this manual.

# **Service Information**

#### WARNING

The information in this section is intended only for qualified service personnel. Some of the procedures may expose you to hazardous voltages that could result in personal injury or death. Do not attempt to perform these procedures unless you are qualified to do so.

## Introduction

This section contains information necessary to service the Model 7021 multiplexer-digital I/O card and is arranged as follows:

- Handling and cleaning precautions Discusses handling precautions and methods to clean the card should it become contaminated.
- Performance verification Covers the procedures necessary to determine if the multiplexer meets stated specifications.
- Functionality test Provides a test procedure to determine if a digital I/O input or output channel is functioning properly.
- Special handling of static-sensitive devices Reviews precautions necessary when handling static-sensitive devices.
- Principles of operation Briefly discusses circuit operation.

• **Troubleshooting** — Presents some troubleshooting tips for the Model 7021 including relay replacement precautions.

# **Handling and cleaning precautions**

Because of the high impedance areas on the Model 7021, care should be taken when handling or servicing the card to prevent possible contamination, which could degrade performance. The following precautions should be taken when servicing the card.

Do not store or operate the card in an environment where dust could settle on the circuit board. Use dry nitrogen gas to clean dust off the board if necessary.

Handle the card only by the edges and shields. Do not touch any board surfaces, components, or connectors. Do not touch areas adjacent to electrical contacts. When servicing the card, wear clean cotton gloves.

If making solder repairs on the circuit board, use an OA-based (organic activated) flux. Remove the flux from the work areas when the repair is complete. Use pure water along with plenty of clean cotton swabs or a clean soft brush to remove the flux. Take care not to spread the flux to other areas of the circuit board. Once the flux has been removed, swab only the repaired area with methanol, then blowdry the board with dry nitrogen gas.

After cleaning, the card should be placed in a 50°C low humidity environment for several hours before use.

## **Performance verification**

The following paragraphs discuss performance verification procedures for the Model 7021, including path resistance, offset current, contact potential, and isolation.

With the Model 7021's backplane jumpers installed, the performance verification procedures must be performed with only one card (the one being checked) installed in the Model 7001/7002 mainframe. These conditions do not apply if the backplane jumpers are removed.

### **CAUTION**

Contamination will degrade the performance of the card. To avoid contamination, always grasp the card by the side edges and shields. Do not touch the connectors and do not touch the board surfaces or components. On plugs and receptacles, do not touch areas adjacent to the electrical contacts.

#### NOTE

Failure of any performance verification test may indicate that the card is contaminated. See the Handling and cleaning precautions paragraph to clean the card.

## **Environmental conditions**

All verification measurements should be made at an ambient temperature between 18° and 28°C and at a relative humidity of less than 70%.

# Recommended equipment

Table 6-1 summarizes the equipment necessary for performance verification, along with an application for each unit.

# **Multiplexer connections**

The following information summarizes methods that can be used to connect test instrumentation to the card. Detailed connection information is provided in Section 4.

One method to make instrument connections to the card is by hard-wiring a 96-pin female DIN connector and then mating it to the connector on the Model 7021. Input and output shorting connections can also be done at the connector. The connector in the Model 7011-KIT-R connection kit (Table 4-1) can be used for this purpose. Pin identification for the connector is provided by Figure 4-9 and Table 4-2.

Table 6-1
Verification equipment

| Description                      | Model                   | Specifications                        | Applications                   |
|----------------------------------|-------------------------|---------------------------------------|--------------------------------|
| DMM                              | Keithley Model 2000     | 100Ω; 0.01%                           | Path resistance                |
| Electrometer w/voltage source    | Keithley Model<br>6517A | 20pA, 200pA; 1%<br>100V source; 0.15% | Offset current, path isolation |
| Sensitive Digital Voltmeter      | Keithley Model 182      | 3mV; 60ppm                            | Contact potential              |
| Triax cable (unterminated)       | Keithley Model 7025     | _                                     | Offset current                 |
| Low thermal cable (unterminated) | Keithley Model 1484     | _                                     | Contact potential              |

#### WARNING

When wiring a connector and device under test, do not leave any exposed wires or connections. No conductive part of the circuit may be exposed. Properly cover the conductive parts, or death by electric shock may occur.

#### **CAUTION**

After making solder connections to a connector, remove solder flux as explained in the Handling and cleaning precautions paragraph. Failure to clean the solder connections could result in degraded performance and prevent the card from passing verification tests.

Before pre-wiring any connectors or plugs, study the following test procedures to fully understand the connection requirements.

## **Channel resistance tests**

Referring to Figure 6-1, perform the following steps to verify that each contact of every relay is closing properly and that the resistance is within specification.

- 1. Turn off the Model 7001/7002 if it is on.
- 2. Turn on the Model 2000 and allow it to warm up for one hour before making measurements.
- 3. Connect all input terminals of bank A together to form one common terminal, as shown in Figure 6-1.

- 4. Set the Model 2000 to the  $100\Omega$  range and connect the four test leads to the INPUT and INPUT  $\Omega$  4 WIRE jacks.
- 5. Short the four test leads together and zero the Model 2000. Leave zero enabled for the entire test.
- 6. Connect INPUT HI and INPUT  $\Omega$  4 WIRE HI of the Model 2000 to the common terminal (jumper on bank A inputs). It is recommended that the physical connections be made at the inputs of bank A, as shown in Figure 6-1.
- 7. Connect INPUT LO and INPUT  $\Omega$  4 WIRE LO to the HI (H) terminal of bank A.
- 8. Install the Model 7021 in slot 1 (CARD 1) of the Model 7001/7002.
- 9. Turn on the Model 7001/7002 and program it to close channel 1!1 (bank A, input 1). Verify that the resistance of this path is  $<1.25\Omega$ .
- 10. Open channel 1!1 and close channel 1!2 (bank A, input 2). Verify that the resistance of this path is  $<1.25\Omega$ .
- 11. Using the basic procedure in steps 9 and 10, check the resistance of bank A HI (H) terminal paths for the rest of the bank A inputs (channels 1!6, 1!7, 1!11, 1!12, 1!16, 1!17, 1!21, 1!22, 1!26, and 1!27).
- 12. Turn off the Model 7001/7002 and move the INPUT LO and INPUT  $\Omega$  4 WIRE LO test leads to the LO (L) terminal of bank A.
- 13. Repeat steps 9 through 11 to check the LO (L) terminal paths of bank A (channels 1!1, 1!2, 1!6, 1!7, 1!11, 1!12, 1!16, 1!17, 1!21, 1!22, 1!26, and 1!27).
- 14. Repeat the basic procedure in steps 1 through 13 for bank B (channels 1!3-1!5, 1!8-1!10, 1!13-1!15, 1!18-1!20, 1!23-1!25, and 1!28-1!30).

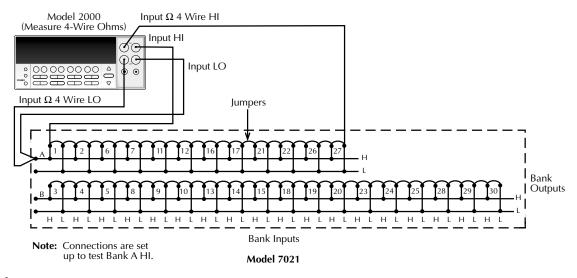


Figure 6-1
Path resistance test connections

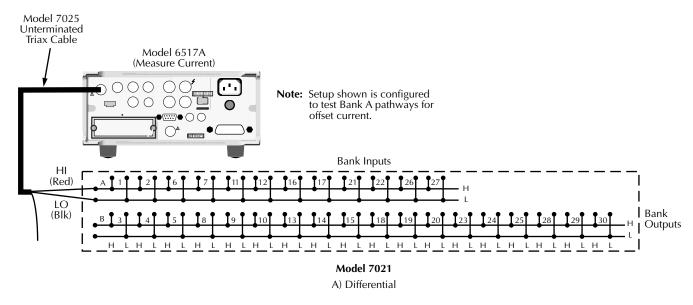
## Offset current tests

These tests check leakage current between HI (H) and LO (L) (differential offset current) and from HI (H) and LO (L) to chassis (common-mode offset current) of each pathway. In general, these tests are performed by measuring the leakage current with an electrometer. In the following procedure, the Model 6517A is used to measure the leakage current.

Referring to Figure 6-2, perform the following procedure to check offset current:

- 1. Turn off the Model 7001/7002 if it is on, and remove any jumpers or wires connected to the card.
- 2. Connect the triax cable to the Model 6517A, but do not connect it to the card at this time.
- Turn on the Model 6517A and allow the unit to warm up for two hours before testing. After warm up, select the 200pA range, enable zero check, and zero correct the instrument. Leave zero correct enabled for the entire procedure.
- 4. Connect the triax cable to bank A HI and LO, as shown in Figure 6-2A.
- 5. Install the Model 7021 in slot 1 (CARD 1) of the main-frame.
- 6. Turn on the Model 7001/7002.

- 7. Program the unit to close channel 1!1 (bank A, input 1).
- 8. On the Model 6517A, disable zero check and allow the reading to settle. Verify that the reading is <100pA. This measurement is the offset (leakage) current of the pathway.
- 9. Enable zero check on the Model 6517A and open channel 1!1 from the front panel of the mainframe.
- 10. Repeat the basic procedure in steps 7 through 9 to check the rest of the pathways of bank A (channels 1!2, 1!6, 1!7, 1!11, 1!12, 1!16, 1!17, 1!21, 1!22, 1!26, and 1!27).
- 11. Turn off the mainframe and change the electrometer connections to bank B.
- 12. Repeat the basic procedure in steps 7 through 10 to check the bank B inputs (channels 1!3-1!5, 1!8-1!10, 1!13-1!15, 1!18-1!20, 1!23-1!25, and 1!28-1!30).
- 13. Turn off the Model 7001/7002 and change the electrometer connections, as shown in Figure 6-2B. Note that electrometer HI is connected to HI and LO of the bank A output, which are jumpered together. Electrometer LO is connected to chassis.
- 14. Turn on the Model 7001/7002.
- 15. Repeat steps 7 through 12 to check that the common-mode offset current is <100pA.



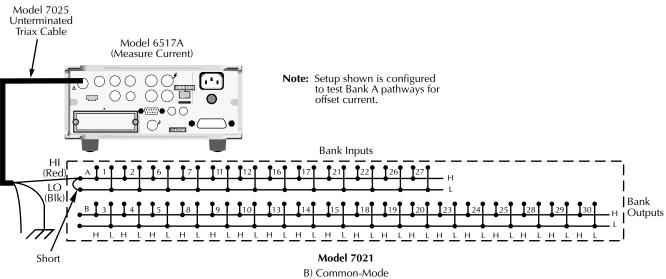


Figure 6-2
Offset current test connections

# **Contact potential tests**

These tests check the EMF generated by each relay contact pair (H and L) for each pathway. The tests consist of using a sensitive digital voltmeter (Model 182) to measure the contact potential.

Referring to Figure 6-3, perform the following procedure to check contact potential of each path:

- 1. Turn off the Model 7001/7002 if it is on.
- 2. Place jumpers between banks A and B.
- 3. Turn on the Model 182 and allow the unit to warm up to achieve rated accuracy.
- 4. Place a short between HI to LO on each input (channels 1!1-1!30).
- 5. Place a short between HI to LO on output bank B (long enough to cut with wire cutters).
- 6. Connect the Model 182 input leads to HI and LO on output bank A using copper wires.

- 7. Install the Model 7021 in the Model 7001/7002 slot 1, and turn on the mainframe.
- 8. Allow Models 7001/7002, 7021, and 182 to warm up for two hours.
- 9. Select the 3mV range on the Model 182.
- 10. Press REL READING on the Model 182 to null out internal offsets. Leave REL READING enabled for the entire procedure.
- 11. Turn off the mainframe. Remove the Model 7021 from slot 1. Cut the short on bank B output HI to LO.
- 12. Install the Model 7021 in mainframe slot 1, and turn power on.
- 13. Wait 15 minutes.
- 14. Program the mainframe to close channel 1!1.
- 15. After settling, verify that reading on the Model 182 is  $<3\mu V$ . This measurement represents the contact potential of the pathway.
- 16. From the mainframe, open channel 1!1.
- 17. Repeat steps 14 through 16 for all 30 channels.

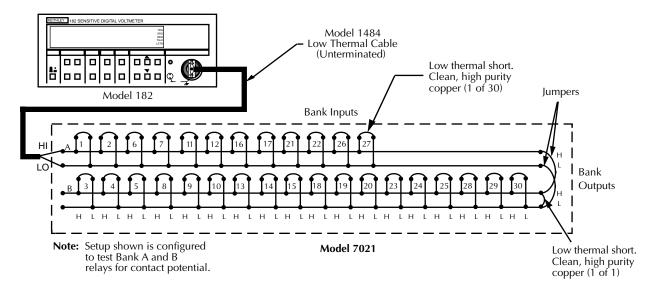


Figure 6-3
Contact potential test connections

## Bank and channel-to-channel isolation tests

Bank isolation tests check the leakage resistance between adjacent banks. Channel-to-channel isolation tests check the leakage resistance between a bank output connection and a bank input connection with an adjacent bank input relay closed. In general, the tests are performed by applying a voltage (100V) across the leakage resistance and then measuring the current. The isolation resistance is then calculated as R = V/I. In the following procedure, the Model 6517A functions as both a voltage source and an ammeter. In the R function, the Model 6517A internally calculates the resistance from the known voltage and current levels and displays the resistive value.

Perform the following steps to check bank and channel-tochannel isolation:

- 1. Turn off the Model 7001/7002 if it is on, and remove any jumpers or test leads connected to the card.
- 2. Turn on the Model 6517A and allow the unit to warm up for two hours before testing.
- 3. Connect the electrometer to the Model 7021, as shown in Figure 6-4. Make sure the voltage source is off. Also, make sure there are no other connections to the card.

4. Install the Model 7021 in slot 1 (CARD 1) and turn on the mainframe.

#### WARNING

The following steps use hazardous voltage (100V). Be sure to remove power from the circuit before making connection changes.

- 5. Place the Model 6517A in the R measurement function.
- 6. Turn on and program the Model 7001/7002 to close channels 1!1 and 1!4 (bank A, input 1 and bank B, input 4).
- 7. On the Model 6517A, source +100V.
- 8. After allowing the reading on the Model 6517A to settle, verify that it is  $>1G\Omega$  ( $10^9\Omega$ ). This measurement is the leakage resistance (bank isolation) between bank A, input 1 and bank B, input 4.
- 9. Using Table 6-2 as a guide, repeat the basic procedure of steps 6 through 8 for the rest of the path pairs (test numbers 2 through 12 in the table).
- 10. Turn off the Model 6517A voltage source.

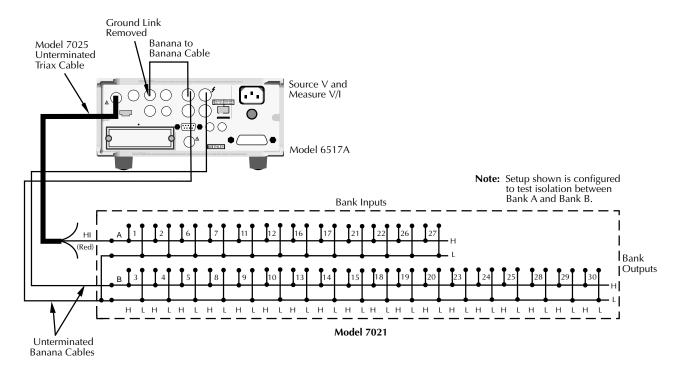


Figure 6-4
Bank isolation test connections

#### NOTE

Refer to the following procedure to check channel-to-channel isolation.

- 11. Turn off the mainframe and connect the Model 6517A to the card as shown in Figure 6-5.
- 12. Install the Model 7021 in slot 1 and turn on the main-frame.
- 13. Program the mainframe to close channel 1!2 (bank A, input 2). Make sure all other channels are open.

- 14. On the Model 6517A, source 100V.
- 15. After allowing the reading on the Model 6517A to settle, verify that it is  $>1G\Omega$  ( $10^9\Omega$ ).
- 16. Turn off the Model 6517A voltage source.
- 17. Using Table 6-3 as a guide, perform tests 2 through 11 for the remaining bank A inputs. Remember to move bank input connections as indicated in the table.
- 18. Use Table 6-3 (test numbers 12 through 28) and the above procedure to test bank B inputs.

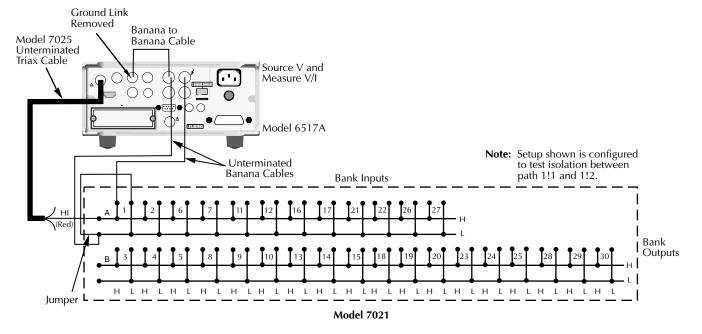


Figure 6-5
Channel-to-channel isolation test connections

Table 6-2 Bank isolation test summary

| Test<br>number | Bank isolation                       | Test equipment location | Channels closed* |
|----------------|--------------------------------------|-------------------------|------------------|
| 1              | Bank A, Input 1 to Bank B, Input 4   | Bank A and Bank B       | 1!1 and 1!4      |
| 2              | Bank A, Input 2 to Bank B, Input 5   | Bank A and Bank B       | 1!2 and 1!5      |
| 3              | Bank A, Input 6 to Bank B, Input 8   | Bank A and Bank B       | 1!6 and 1!8      |
| 4              | Bank A, Input 7 to Bank B, Input 9   | Bank A and Bank B       | 1!7 and 1!9      |
| 5              | Bank A, Input 11 to Bank B, Input 10 | Bank A and Bank B       | 1!11 and 1!10    |
| 6              | Bank A, Input 12 to Bank B, Input 13 | Bank A and Bank B       | 1!12 and 1!13    |
| 7              | Bank A, Input 16 to Bank B, Input 14 | Bank A and Bank B       | 1!16 and 1!14    |
| 8              | Bank A, Input 17 to Bank B, Input 15 | Bank A and Bank B       | 1!17 and 1!15    |
| 9              | Bank A, Input 21 to Bank B, Input 18 | Bank A and Bank B       | 1!21 and 1!18    |
| 10             | Bank A, Input 22 to Bank B, Input 19 | Bank A and Bank B       | 1!22 and 1!19    |
| 11             | Bank A, Input 26 to Bank B, Input 20 | Bank A and Bank B       | 1!26 and 1!20    |
| 12             | Bank A, Input 27 to Bank B, Input 23 | Bank A and Bank B       | 1!27 and 1!23    |

<sup>\*</sup>Assumes Model 7021 is installed in slot 1 of mainframe. Programmed as slot (1) and channel.

Table 6-3 Channel-to-channel isolation test summary

| Test<br>number | Channel-to-channel isolation         | Test equipment location | Channel closed* |
|----------------|--------------------------------------|-------------------------|-----------------|
| 1              | Bank A, Input 1 to Bank A, Input 2   | Bank A and Input 1      | 1!2             |
| 2              | Bank A, Input 2 to Bank A, Input 6   | Bank A and Input 2      | 1!6             |
| 3              | Bank A, Input 6 to Bank A, Input 7   | Bank A and Input 6      | 1!7             |
| 4              | Bank A, Input 7 to Bank A, Input 11  | Bank A and Input 7      | 1!11            |
| 5              | Bank A, Input 11 to Bank A, Input 12 | Bank A and Input 11     | 1!12            |
| 6              | Bank A, Input 12 to Bank A, Input 16 | Bank A and Input 12     | 1!16            |
| 7              | Bank A, Input 16 to Bank A, Input 17 | Bank A and Input 16     | 1!17            |
| 8              | Bank A, Input 17 to Bank A, Input 21 | Bank A and Input 17     | 1!21            |
| 9              | Bank A, Input 21 to Bank A, Input 22 | Bank A and Input 21     | 1!22            |
| 10             | Bank A, Input 22 to Bank A, Input 26 | Bank A and Input 22     | 1!26            |
| 11             | Bank A, Input 26 to Bank A, Input 27 | Bank A and Input 26     | 1!27            |
| 12             | Bank B, Input 3 to Bank B, Input 4   | Bank B and Input 3      | 1!4             |
| 13             | Bank B, Input 4 to Bank B, Input 5   | Bank B and Input 4      | 1!5             |
| 14             | Bank B, Input 5 to Bank B, Input 8   | Bank B and Input 5      | 1!8             |
| 15             | Bank B, Input 8 to Bank B, Input 9   | Bank B and Input 8      | 1!9             |
| 16             | Bank B, Input 9 to Bank B, Input 10  | Bank B and Input 9      | 1!10            |
| 17             | Bank B, Input 10 to Bank B, Input 13 | Bank B and Input 10     | 1!13            |
| 18             | Bank B, Input 13 to Bank B, Input 14 | Bank B and Input 13     | 1!14            |
| 19             | Bank B, Input 14 to Bank B, Input 15 | Bank B and Input 14     | 1!15            |
| 20             | Bank B, Input 15 to Bank B, Input 18 | Bank B and Input 15     | 1!18            |
| 21             | Bank B, Input 18 to Bank B, Input 19 | Bank B and Input 18     | 1!19            |
| 22             | Bank B, Input 19 to Bank B, Input 20 | Bank B and Input 19     | 1!20            |
| 23             | Bank B, Input 20 to Bank B, Input 23 | Bank B and Input 20     | 1!23            |
| 24             | Bank B, Input 23 to Bank B, Input 24 | Bank B and Input 23     | 1!24            |
| 25             | Bank B, Input 24 to Bank B, Input 25 | Bank B and Input 24     | 1!25            |
| 26             | Bank B, Input 25 to Bank B, Input 28 | Bank B and Input 25     | 1!28            |
| 27             | Bank B, Input 28 to Bank B, Input 29 | Bank B and Input 28     | 1!29            |
| 28             | Bank B, Input 29 to Bank B, Input 30 | Bank B and Input 29     | 1!30            |

<sup>\*</sup>Assumes Model 7021 is installed in slot 1 of mainframe. Programmed as slot (1) and channel.

#### Differential and common-mode isolation tests

These tests check the leakage resistance (isolation) between HI (H) and LO (L) (differential) and from HI (H) and LO (L) to chassis (common-mode) of every bank and channel. In general, the test is performed by applying a voltage (100V) across the terminals and then measuring the leakage current. The isolation resistance is then calculated as R = V/I. In the following procedure, the Model 6517A functions as a voltage source and an ammeter. In the R function, the Model 6517A internally calculates the resistance from the known voltage and current levels and displays the resistance value.

Perform the following steps to check differential and common mode isolation:

- Turn off the Model 7001/7002 mainframe if it is on, and remove any jumpers and test leads connected to the card.
- 2. Turn on the Model 6517A and allow the unit to warm up for two hours for rated accuracy.

#### WARNING

The following steps use high voltage (100V). Be sure to remove power from the circuit before making connection changes.

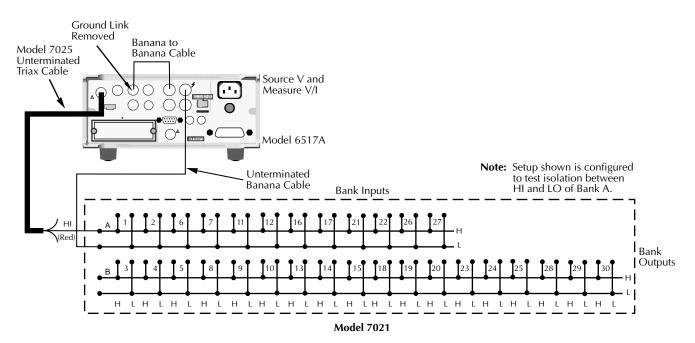


Figure 6-6
Differential isolation test connections

- 3. On the Model 6517A, set the voltage source for +100V. Make sure the voltage source is off.
- 4. Place the Model 6517A in the R measurement function.
- 5. Make sure the Model 6517A voltage source is off and connect the electrometer to bank A as shown in Figure 6-6.
- 6. Install the Model 7021 in slot 1 (CARD 1), and turn on the mainframe.
- 7. Make sure all the relays are open.
- 8. On the Model 6517A, source 100V.
- 9. After allowing the reading on the Model 6517A to settle, verify that it is  $>1G\Omega$  ( $10^9\Omega$ ). This measurement is the differential leakage resistance (isolation) of bank A.
- 10. Turn off the Model 6517A voltage source.
- 11. Program the mainframe to close channel 1!1 (bank A, input 1).
- 12. On the Model 6517A, source +100V.
- 13. After allowing the reading on the Model 6517A to settle, verify that it is also >1G $\Omega$  (10<sup>9</sup> $\Omega$ ). This measurement checks the differential isolation of input 1.

- 14. Using Table 6-4 as a guide, repeat the basic procedure in steps 10 through 13 to test the rest of the inputs of bank A (test numbers 3 through 13 of the table).
- 15. Use Table 6-4 (test numbers 14 through 32) and steps 5 through 13 to test bank B.
- 16. Turn off the Model 6517A voltage source.

#### **NOTE**

Refer to Figure 6-7 for the following procedure to check common-mode isolation.

- 17. Turn off the mainframe, and connect the electrometer to the Model 7021 as shown in Figure 6-7.
- 18. Repeat steps 3 through 15 to check common-mode isolation. Verify that each reading is  $>1G\Omega$  ( $10^9\Omega$ ).

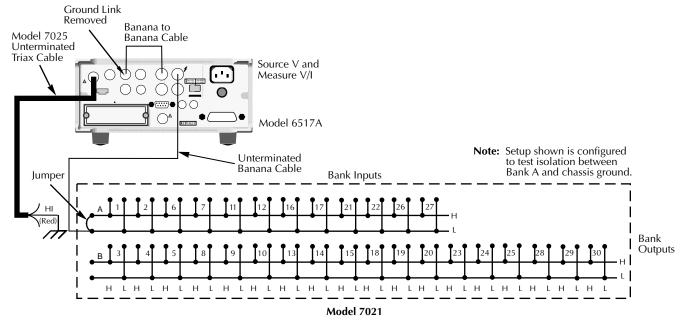


Figure 6-7
Common-mode isolation test connections

 Table 6-4

 Differential and common-mode isolation testing

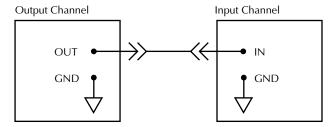
| Test<br>number | Differential or common-mode isolation | Channel closed* |
|----------------|---------------------------------------|-----------------|
| 1              | Bank A                                | None            |
| 2              | Bank A, Input 1                       | 1!1             |
| 3              | Bank A, Input 2                       | 1!2             |
| 4              | Bank A, Input 6                       | 1!6             |
| 5              | Bank A, Input 7                       | 1!7             |
| 6              | Bank A, Input 11                      | 1!11            |
| 7              | Bank A, Input 12                      | 1!12            |
| 8              | Bank A, Input 16                      | 1!16            |
| 9              | Bank A, Input 17                      | 1!17            |
| 10             | Bank A, Input 21                      | 1!21            |
| 11             | Bank A, Input 22                      | 1!22            |
| 12             | Bank A, Input 26                      | 1!26            |
| 13             | Bank A, Input 27                      | 1!27            |
| 14             | Bank B                                | None            |
| 15             | Bank B, Input 3                       | 1!3             |
| 16             | Bank B, Input 4                       | 1!4             |
| 17             | Bank B, Input 5                       | 1!5             |
| 18             | Bank B, Input 8                       | 1!8             |
| 19             | Bank B, Input 9                       | 1!9             |
| 20             | Bank B, Input 10                      | 1!10            |
| 21             | Bank B, Input 13                      | 1!13            |
| 22             | Bank B, Input 14                      | 1!14            |
| 23             | Bank B, Input 15                      | 1!15            |
| 24             | Bank B, Input 18                      | 1!18            |
| 25             | Bank B, Input 19                      | 1!19            |
| 26             | Bank B, Input 20                      | 1!20            |
| 27             | Bank B, Input 23                      | 1!23            |
| 28             | Bank B, Input 24                      | 1!24            |
| 29             | Bank B, Input 25                      | 1!25            |
| 30             | Bank B, Input 28                      | 1!28            |
| 31             | Bank B, Input 29                      | 1!29            |
| 32             | Bank B, Input 30                      | 1!30            |

<sup>\*</sup>Assumes Model 7021 is installed in slot 1 of mainframe. Programmed as slot (1) and channel.

# **Channel functionality test**

- As shown in Figure 6-8, connect the suspect input or output channel to an output or input channel that is known to be functioning properly. The internal 5V supply must be used.
- 2. From the front panel of the mainframe, turn on (close) the output channel. Verify that the display indicates that the output channel is on (closed). Keep in mind that the

- output can be high (positive) or low (negative) when the channel is turned on, depending on the logic configuration.
- 3. Place the mainframe in the "read input channels" display mode. Verify on the display that the input channel is off (open).
- 4. On the mainframe, turn off (open) the output channel and verify on the display that the input channel turns on (closes).
- 5. On the mainframe, return the instrument to the normal display mode and verify on the display that the output channel is off (open).



Internal connections:

Internal voltage source (+5V) selected. Pull-up resistor installed.

Figure 6-8
Testing an input or output channel

# **Special handling of static-sensitive devices**

CMOS and other high-impedance devices are subject to possible static discharge damage because of the high-impedance levels involved. When handling such devices, use the precautions listed below.

#### NOTE

In order to prevent damage, assume that all parts are static-sensitive.

- Such devices should be transported and handled only in containers specially designed to prevent or dissipate static buildup. Typically, these devices will be received in anti-static containers made of plastic or foam. Keep these parts in their original containers until ready for installation or use.
- Remove the devices from their protective containers only at a properly grounded workstation. Also, ground yourself with an appropriate wrist strap while working with these devices.
- 3. Handle the devices only by the body; do not touch the pins or terminals.

- 4. Any printed circuit board into which the device is to be inserted must first be grounded to the bench or table.
- 5. Use only anti-static type de-soldering tools and grounded-tip soldering irons.

# **Principles of operation**

The following paragraphs discuss the basic operating principles for the Model 7021 and can be used as an aid in trouble-shooting the card. Schematic drawings 7021-106 and 7021-172 are located in Section 7.

## **Block diagram**

Figure 6-9 shows a simplified block diagram of the Model 7021. Key elements include the ROM, which contains card ID and configuration information, multiplexer relay drivers and relays, and digital I/O output channel drivers and digital I/O input channel registers. These various elements are discussed in the following paragraphs.

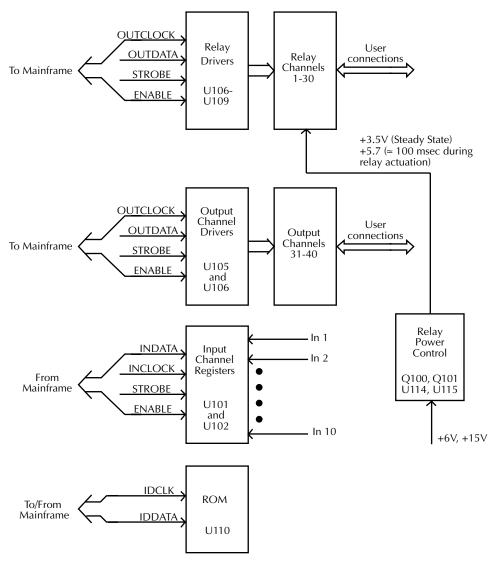


Figure 6-9 Model 7021 block diagram

#### **ID** data circuits

Upon power-up, card identification information from each card is read by the mainframe. This ID data includes such information as card ID, hardware settling time, and relay and channel configuration information.

ID data is contained within an on-card EEPROM (U110). In order to read this information, the sequence described below is performed on power-up.

- 1. The IDDATA line (pin 5 of U110) is set from high to low while the IDCLK line (pin 6 of U110) is held high. This action initiates a start command to the ROM to transmit data serially to the mainframe (Figure 6-10).
- 2. The mainframe sends the ROM address location to be read over the IDDATA line. The ROM then transmits an acknowledge signal back to the mainframe, and it then transmits data at that location back to the mainframe (Figure 6-11).
- The mainframe then transmits an acknowledge signal, indicating that it requires more data. The ROM will then sequentially transmit data after each acknowledge signal it receives.

4. Once all data is received, the mainframe sends a stop command, which is a low-to-high transition of the ID-DATA line with the IDCLK line held high (Figure 6-10).

#### Multiplexer relay control

Card relays are controlled by serial data transmitted via the relay DATA line. A total of five bytes for each card are shifted in serial fashion into latches located in the card relay driver ICs. The serial data is clocked in by the CLK line. As data overflows one register, it is fed out the Q's line of the register down the chain.

Once all five bytes have shifted into the card, the STROBE line is set high to latch the relay information into the Q outputs of the relay drivers, and the appropriate relays are energized (assuming the driver outputs are enabled, as discussed below). Note that a relay driver output goes low to energize the corresponding relay.

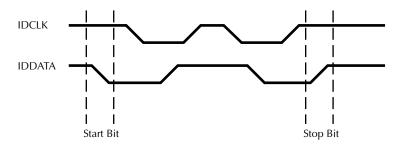


Figure 6-10
Start and stop sequences

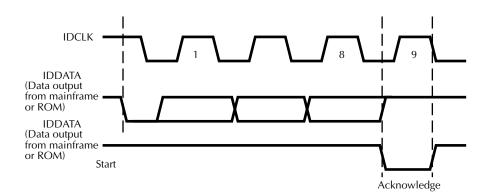


Figure 6-11
Transmit and acknowledge sequence

## Multiplexer relay power control

A relay power control circuit, made up of U114, U115, Q100, Q101, and associated components, keeps power dissipated in relay coils at a minimum, thus reducing possible problems caused by thermal EMFs.

During steady-state operation, the relay supply voltage, +V, is regulated to +3.5V to minimize coil power dissipation. When a relay is first closed, the STROBE pulse applied to U114 changes the parameters of the relay supply voltage regulator, Q100, allowing the relay supply voltage, +V, to rise to +5.7V for about 100msec. This brief voltage rise ensures that relays close as quickly as possible. After the 100msec period has elapsed, the relay supply voltage (+V) drops back down to its nominal steady-state value of +3.5V.

#### Digital I/O output channel control

Digital output channels are controlled by serial data transmitted from the mainframe to the card via the OUTDATA line. A total of two bytes are shifted in a serial fashion into latches located in the output channel driver ICs. The serial data is clocked in by the OUTCLK line. As data overflows one register, it is fed out the Q's line of the register down the chain.

Once all bytes have shifted into the card, the STROBE line is set high to latch the output channel information into the Q outputs of the output channel drivers. Note that a channel driver output can go low or high when it is turned on (closed) depending on its logic configuration.

#### Digital I/O input channel control

The mainframe reads digital input channels of the I/O card from a serial, two-byte data stream (via INDATA line).

Digital inputs are applied in a parallel fashion to the two input channel registers (U102 contains eight channels and U101 contains two channels). When the digital inputs are read, the STROBE line goes high to latch the input channel information. The INCLOCK line then clocks out the information as a serial, two-byte data stream (via INDATA line) to the mainframe. As data empties from the lead register (U101), it is replaced by data via the Q7 line of the registers down the chain.

## Power-on safeguard

#### **NOTE**

The power-on safeguard circuit discussed below is actually located on the digital board in the mainframe.

A power-on safeguard circuit, made up of a D-type flip-flop and associated components ensures that relays and digital I/O output channels do not randomly energize on power-up and power-down. This circuit disables all relays and output channels (all relays and output channels are open) during power-up and power-down periods.

The PRESET line on the D-type flip-flop is controlled by the 68302 microprocessor, while the CLK line of the D-type flip-flop is controlled by a VIA port line on the 68302 processor. The Q output of the flip-flop drives each card relay/output channel driver IC enable pin (U105-U109, pin 8).

When the 68302 microprocessor is in the reset mode, the flip-flop PRESET line is held low, and Q out immediately goes high, disabling all relays and output channels (driver IC enable pins are high). After the reset condition elapses (≈200msec), PRESET goes high while Q out stays high. When the first valid STROBE pulse occurs, a low logic level is clocked into the D-type flip-flop, setting Q out low and enabling all relay drivers and output channel drivers simultaneously. Note that Q out stays low, (enabling relay drivers and output channel drivers) until the 68302 processor goes into a reset condition.

## **Troubleshooting**

#### WARNING

Lethal voltages are present within the Model 7001/7002 mainframe. Some of the procedures may expose you to hazardous voltages. Observe standard safety precautions for dealing with live circuits. Failure to do so could result in personal injury or death.

#### **CAUTION**

Observe the following precautions when troubleshooting or repairing the card:

To avoid contamination, which could degrade card performance, always handle the card only by the handle and side edges. Do not touch edge connectors, board surfaces, or components on the card. Also, do not touch areas adjacent to electrical contacts on connectors.

Use care when removing relays from the PC board to avoid pulling traces away from the circuit board. Before attempting to remove a relay, use an appropriate de-soldering tool, such as a solder sucker, to clear each mounting hole completely free of solder. Each relay pin must be free to move in its mounting hole before removal. Also, make certain that no burrs are present on the ends of the relay pins.

## **Troubleshooting equipment**

Table 6-5 summarizes recommended equipment for trouble-shooting the Model 7021.

 Table 6-5

 Recommended troubleshooting equipment

| Description  | Manufacturer and model | Application          |
|--------------|------------------------|----------------------|
| Multimeter   | Keithley 2000          | Measure DC voltages  |
| Oscilloscope | TEK 2243               | View logic waveforms |

#### **Troubleshooting access**

In order to gain access to the relay card top surface to measure voltages under actual operation conditions, perform the following steps:

- 1. Disconnect the connector card from the relay card.
- 2. Remove the mainframe cover.
- 3. Install the relay card in the CARD 1 slot location.
- 4. Turn on Model 7001/7002 power to measure voltages (see the Troubleshooting procedure paragraph).

# **Troubleshooting procedure**

Table 6-6 summarizes multiplexer-digital I/O card trouble-shooting.

Table 6-6
Troubleshooting procedure

| Step | Item/component        | Required condition                                      | Comments   |
|------|-----------------------|---|--|
| 1    | GND pad               |   | All voltages referenced to digital ground (GND pad). |
| 2    | Q100, pin 2           | +6VDC   | Relay voltage.                                       |
| 3    | U101, pin 16          | +5VDC   | Logic voltage.                                       |
| 4    | R135                  | +15VDC  | Relay bias voltage.                                  |
| 5    | Q100, pin 3           | +3.5VDC*  | Regulated relay voltage.                             |
| 6    | U110, pin 6           | IDCLK pulses  | During power-up only.                                |
| 7    | U110, pin 5           | IDDATA pulses   | During power-up only.                                |
| 8    | U106, pin 7           | STROBE pulse  | End of relay update sequence.                        |
| 9    | U106, pin 2           | CLK pulses  | During relay update sequence only.                   |
| 10   | U106, pin 3           | DATA pulses   | During relay update sequence only.                   |
| 11   | U105-U109, pins 10-18 | Low with relay energized; high with relay de-energized. | Relay driver outputs.                                |

<sup>\*+3.5</sup>VDC present at +V pad under steady-state conditions. This voltage rises to +5.7VDC for about 100msec when relay configuration is changed.

# **7 Replaceable Parts**

#### Introduction

This section contains replacement parts information, schematic diagrams, and component layout drawings for the Model 7021.

#### **Parts lists**

Parts lists for the various circuit boards are included in tables integrated with schematic diagrams and component layout drawings for the boards. Parts are listed alphabetically in order of circuit designation.

# **Ordering information**

To place an order, or to obtain information concerning replacement parts, contact your Keithley representative or the factory (see inside front cover for addresses). When ordering parts, be sure to include the following information:

- 1. Card model number 7021
- 2. Card serial number
- 3. Part description
- 4. Circuit description, if applicable
- 5. Keithley part number

# **Factory service**

If the card is to be returned to Keithley Instruments for repair, perform the following:

- Complete the service form at the back of this manual and include it with the card.
- 2. Carefully pack the card in the original packing carton.
- 3. Write ATTENTION REPAIR DEPT on the shipping label.

#### **NOTE**

It is not necessary to return the mainframe with the card.

# Component layouts and schematic diagrams

Component layout drawings and schematic diagrams are included on the following pages integrated with the parts lists:

Table 7-1 — Parts List, Relay Card for 7021.

7021-100 — Component Layout, Relay Card for 7021.

7021-106 — Schematic, Relay Card for 7021.

#### NOTE

The Model 7021 and 7022 use the same relay card; only the connector cards are different.

- Table 7-2 Parts List, Mass Terminated Connector Card for 7021.
- 7021-170 Component Layout, Mass Terminated Connector Card for 7021.
- 7021-172 Schematic, Mass Terminated Connector Card for 7021.
- Table 7-3 Parts List, Model 7011-KIT-R 96-pin Female DIN Connector Kit.

Table 7-1 Relay card for Model 7021 parts list

| Circuit           |   | Keithley             |
|-------------------|---|----------------------|
| designation       | Description   | part no.             |
|                   | 2-56X3/16 PHILLIPS PAN HEAD SCREW                                       | 3-56X3/16PPH         |
|                   | (BOARD TO SHIELD)   |                      |
|                   | 2-56X5/8 PHILLIPS PAN HEAD FASTENER                                     | FA-245-1             |
|                   | (FOR P2001 TO STANDOFF AND SHIELD)                                      |                      |
|                   | 2-56X7/16 PHILLIPS PAN HEAD SCREW                                       | 2-56X7/16PPH         |
|                   | (BOARD TO SHIELD)   |                      |
|                   | 4-40X3/16 PHILLIPS PAN HEAD SEMS SCREW (FOR Q100)                       | 4-40X3/16PPHSEM      |
|                   | 4-40 PEM NUT  | FA-131               |
|                   | EJECTOR ARM   | 7011-301B            |
|                   | IC, SERIAL EPROM, 24C01P  | IC-737               |
|                   | ROLL PIN (FOR EJECTOR ARMS)   | DP-6-1               |
|                   | SHIELD  | 7011-305C            |
|                   | STANDOFF, 2 CLEARANCE   | ST-204-1             |
| C100-112,114,115, | CAP, 0.1μF, 20%, 50V, CERAMIC   | C-3651               |
| 118,121,122,125   | CAR 150RE 100/ 1000M CER AMIC   | C (4.150D)           |
| C116,117,126      | CAP, 150PF, 10%, 1000V, CERAMIC   | C-64-150P<br>C-237-1 |
| C119,127          | CAP, 1μF, 20%, 50V, CERAMIC<br>CAP, 0.001μF, 20%, 500V, CERAMIC         | C-237-1<br>C-22001   |
| C120<br>C123,124  | CAP, 0.001µF, 20%, 500V, CERAMIC<br>CAP, 10µF, -20+100%, 25V, ALUM ELEC | C-22001<br>C-314-10  |
| C125,124          | CAP, 10µr, -20+100%, 25 v, ALUM ELEC                                    | C-314-10             |
| CR100-119         | DIODE, SILICON, IN4148 (D0-35)  | RF-28                |
| J100,101          | CONN, BERG  | CS-339               |
| J1002,1003        | CONN, 48-PIN, 3-ROW   | CS-736-2             |
| K100-129          | RELAY, ULTRA-SMALL POLARIZED TF2E-5V                                    | RL-149               |
| P2001             | CONN, 32-PIN, 2-ROW   | CS-775-1             |
| Q100              | TRANS, NPN PWR, TIP31 (T0-220AB)  | TG-253               |
| Q101              | TRANS, N CHAN MOSPOW FET, 2N7000 (T0-92)                                | TG-195               |
| R100-130,132      | RES, 10K, 5%, 1/4W, COMPOSITION OR FILM                                 | R-76-10K             |
| R131              | RES, 1K, 5%, 1/4W, COMPOSITION OR FILM                                  | R-76-1K              |
| R133              | RES, 220K, 5%, 1/4W, COMPOSITION OR FILM                                | R-76-220K            |
| R134,135          | RES, 560, 10%, 1/2W, COMPOSITION  | R-1-560              |

Table 7-1 (continued) Relay card for Model 7021 parts list

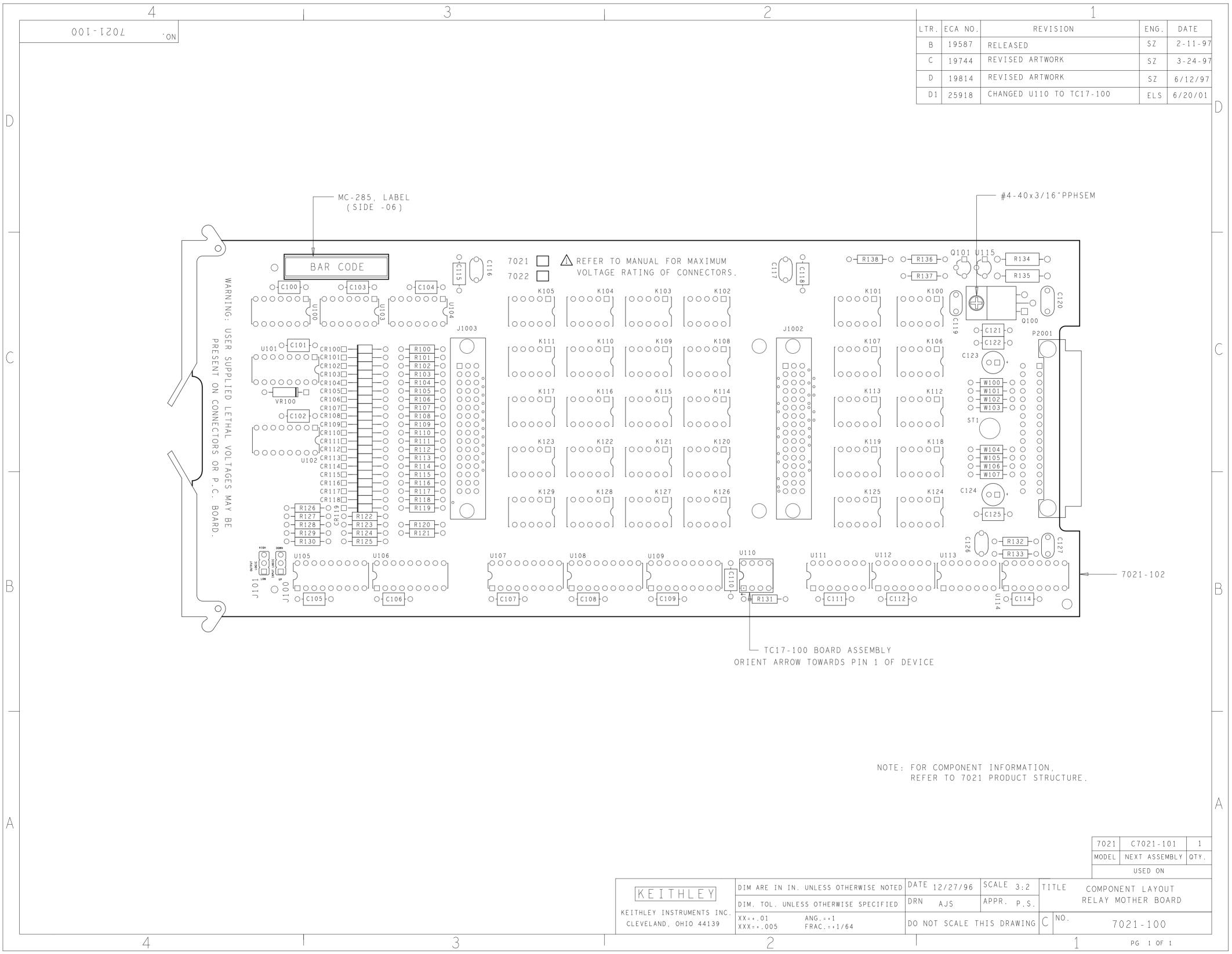
| Circuit      |  | Keithley    |
|--------------|--|-------------|
| designation  | Description                              | part no.    |
| R136         | RES, 2.49K, 1%, 1/8W, METAL FILM         | R-88-2.49K  |
| R137         | RES, 1.15K, 1%, 1/8W, METAL FILM         | R-88-1.15K  |
| R138         | RES, 1K, 1%, 1/8W, METAL FILM            | R-88-1K     |
| S110         | SOCKET                                   | S0-72       |
| ST1          | STANDOFF, 4-40X0.812LG                   | ST-137-20   |
| U100,103,104 | IC, QUAD 2-INPUT EXCLUSIVE OR 74HCT86    | IC-707      |
| U101,102     | IC, 8-BIT PARALLEL TO SERIAL, 74HCT165   | IC-548      |
| U105-109     | IC, 8-BIT, SERIAL-IN LATCH DRIVER, 5841A | IC-536      |
| U110         | EPROM PROGRAM                            | 7021-800A01 |
| U111         | IC, HEX INVERTER, 74HCT04                | IC-444      |
| U112         | IC, QUAD 2 INPUT OR 74HCT32              | IC-443      |
| U113         | IC, HIGH SPEED BUFFER, 74HC125           | IC-451      |
| U114         | IC, RETRIG MONO MULTIVIB, 74HC123        | IC-492      |
| U115         | IC, AJD SHUNT REGULATOR, TL431CLP        | IC-677      |
| VR100        | DIODE, ZENER, 5.1V, IN751 (D0-7)         | DZ-59       |
| W100-107     | JUMPER                                   | J-15        |

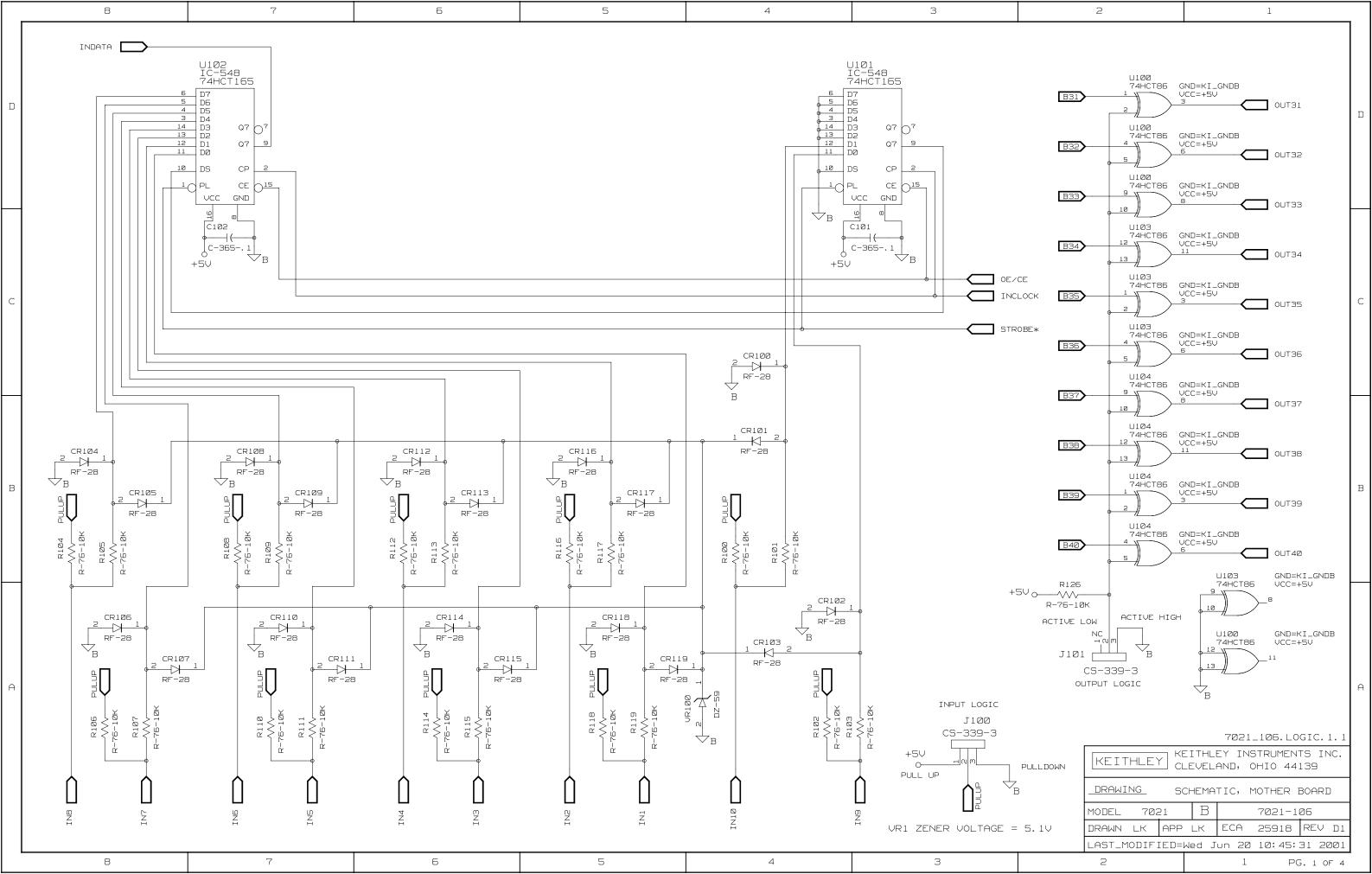
Table 7-2
Mass terminated connector card for Model 7021 parts list

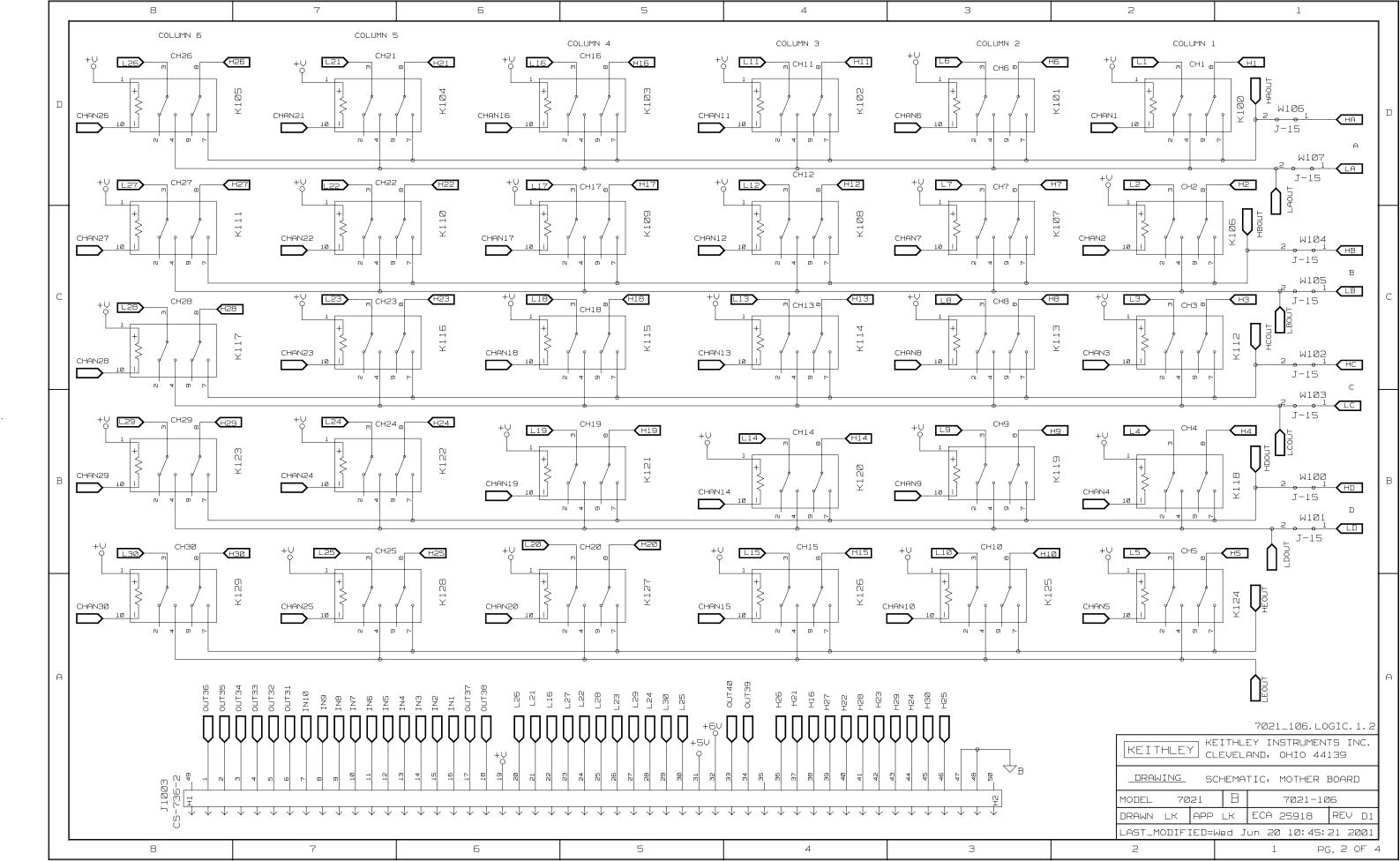
| Circuit                  |  | Keithley       |
|--------------------------|--|----------------|
| designation              | Description                                    | part no.       |
|                          | 2-56X3/16 PHILLIPS PAN HEAD SCREW (FOR SHIELD) | 2-56X3/16PPH   |
|                          | 2-56X3/8 PHILLIPS PAN HEAD SCREW (FOR BRACKET) | 2-56X3/8PPH    |
|                          | 2-56X7/16 PHILLIPS PAN HEAD SCREW              | 2-56X7/16PPH   |
|                          | 4-40X1/4 PHILLIPS PAN HEAD SEMS SCREW          | 4-40X1/4PPHSEM |
|                          | (CONNECTS RELAY BOARD TO CONNECTOR BOARD)      |                |
|                          | BRACKET  | 7011-307       |
|                          | CONN, JUMPER                                   | CS-476         |
|                          | SHIELD   | 7011-311A      |
|                          | STANDOFF                                       | ST-203-1       |
| C201-204                 | CAP, 0.1µF, 20%, 50V, CERAMIC                  | C-3651         |
| CR201,202                | DIODE, SILICON, IN4148 (D0-35)                 | RF-28          |
| J201,204,205             | CONN, BERG                                     | CS-339         |
| J202,203                 | CONN SHIM                                      | 7011-309A      |
| J1004                    | CONN, 96-PIN, 3-ROW                            | CS-514         |
| K201,202                 | RELAY, ULTRA-SMALL POLARIZED TF2E-4.5V         | RL-162         |
| P1002,1003               | CONNECTOR, 48-PIN, 3-ROW                       | CS-748-3       |
| Q201                     | TRANS, NPN SILICON, 2N3904 (T0-92)             | TG-47          |
| R201-205,207-<br>210,212 | RES, 10K, 5%, 1/4W, COMPOSITION OR FILM        | R-76-10K       |
| R206                     | RES, 100K, 5%, 1/4W, COMPOSITION OR FILM       | R-76-100K      |
| R211,213                 | RES, 220, 10%, 1/2W, COMPOSITION               | R-1-220        |
| U201-203                 | IC, 4-CHANNEL PWR DRIVER, 2549B                | IC-1044        |

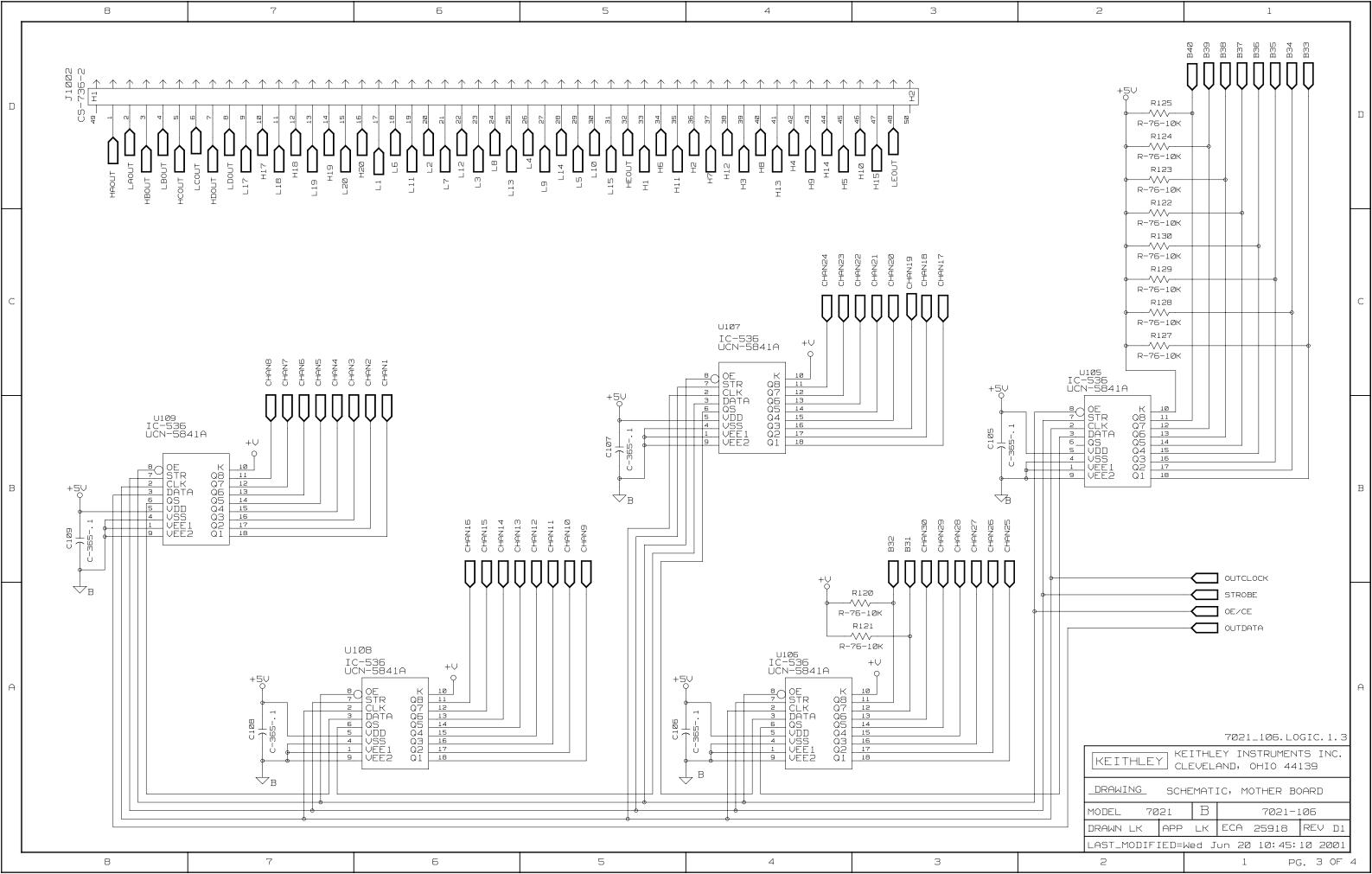
Table 7-3
Model 7011-KIT-R 96-pin female DIN connector kit parts list

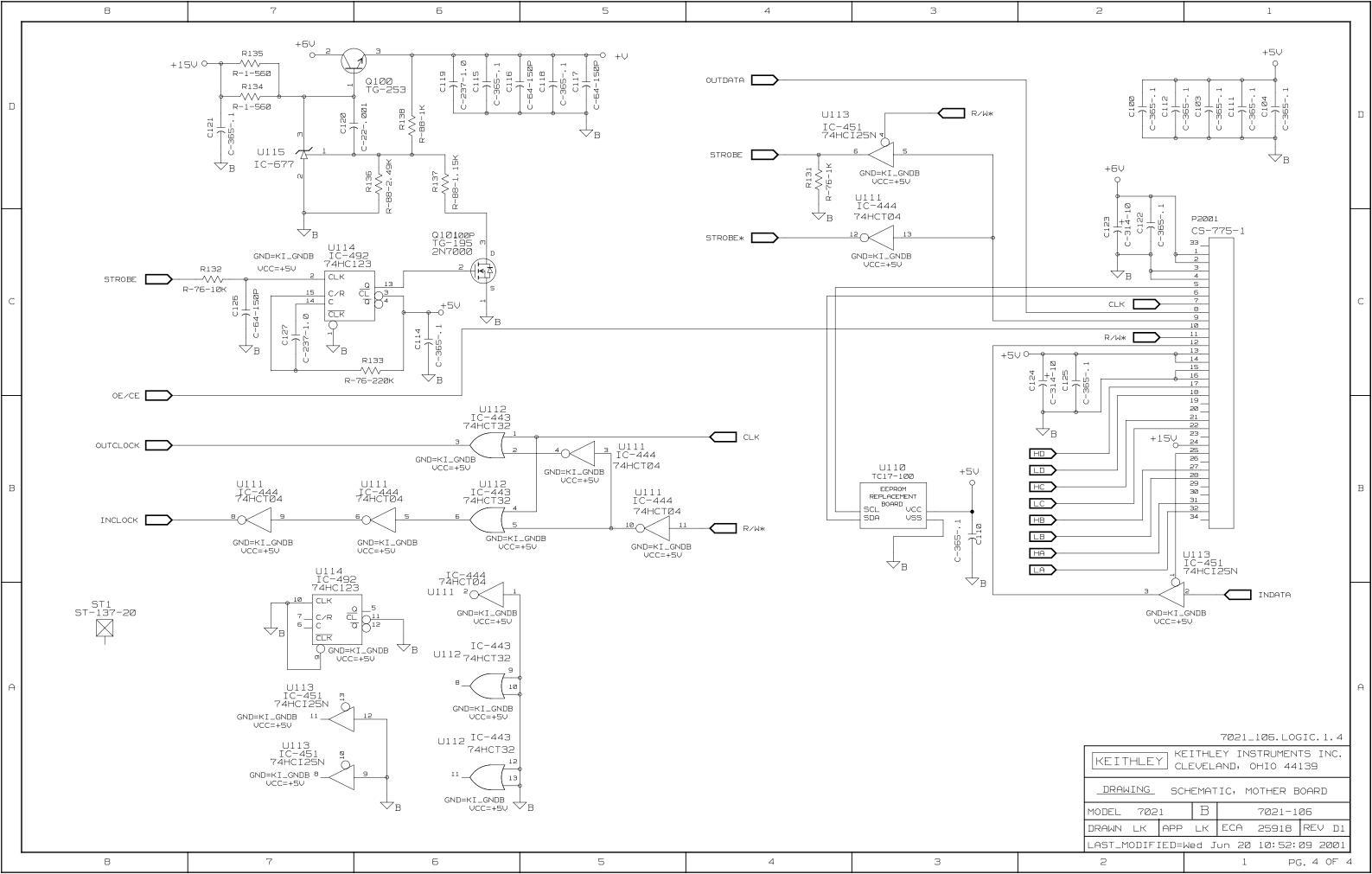
| Description                                  | Keithley part no. |
|--|-------------------|
| 96-PIN FEMALE DIN CONNECTOR                  | CS-787-1          |
| BUSHING, STRAIN RELIEF                       | BU-27             |
| CABLE ADAPTER, REAR EXIT (INCLUDES TWO CABLE | CC-64             |
| CLAMPS)                                      |                   |
| CONNECTOR HOUSING                            | CS-788            |

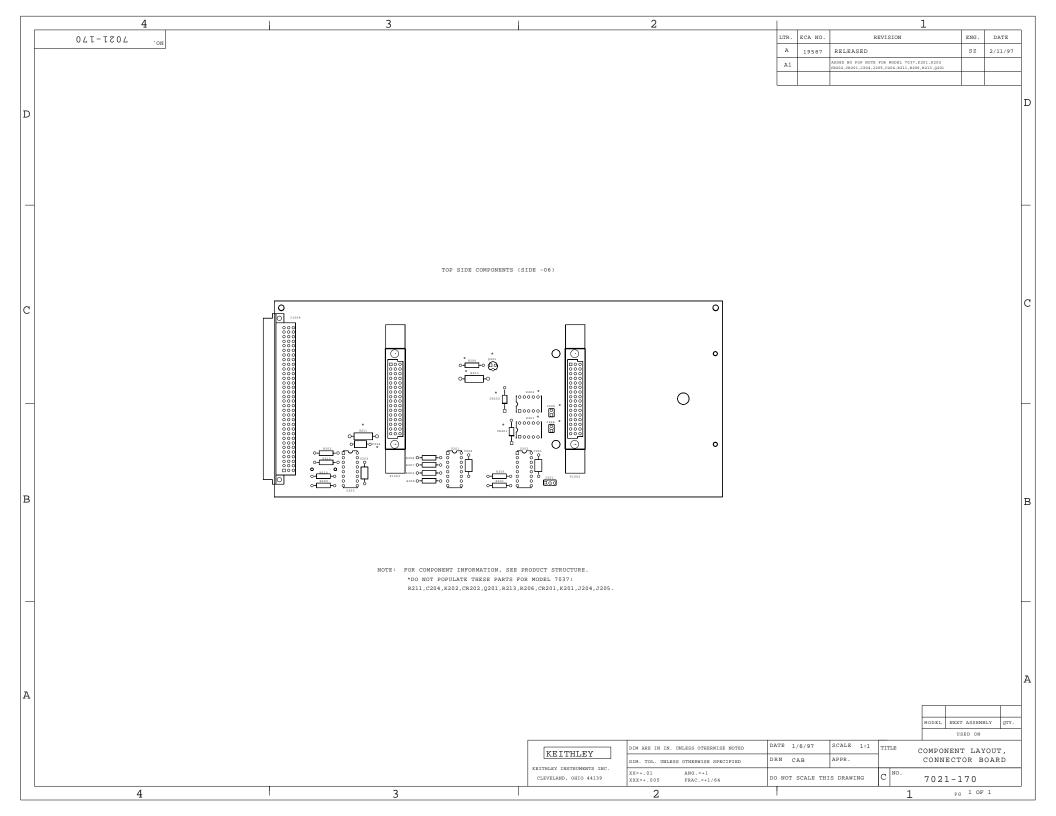


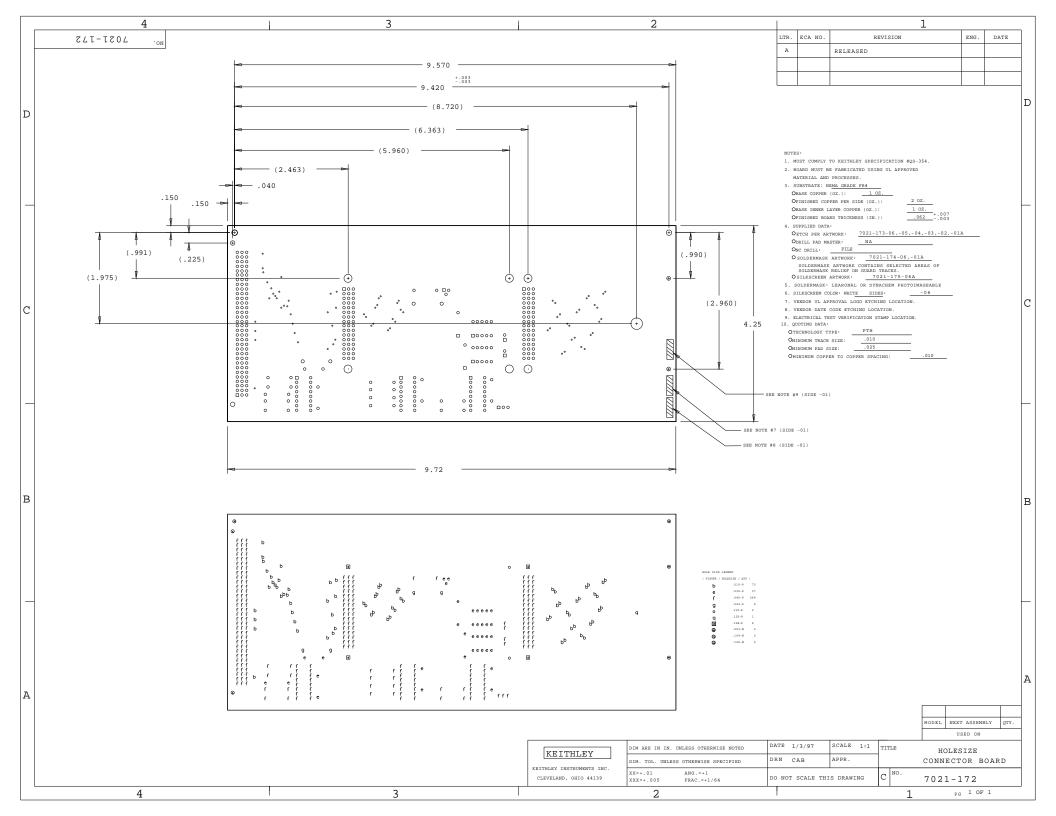












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Be sure to include your name and phone number on this service form.

# **Service Form**

| Model No.   | Serial No   | Date   |
|---|---|--|
| Name and Telephone I  | No  |  |
| Company   |   |  |
| List all control settings, describ  | e problem and check boxes that apply to p   | roblem.  |
| ☐ Intermittent  | ☐ Analog output follows display   | ☐ Particular range or function bad; specify      |
| ☐ IEEE failure<br>☐ Front panel operational   | <ul><li>Obvious problem on power-up</li><li>All ranges or functions are bad</li></ul> | ☐ Batteries and fuses are OK☐ Checked all cables |
| Display or output (check one)   |   |  |
| <ul><li>□ Drifts</li><li>□ Unstable</li><li>□ Overload</li></ul>                                  | ☐ Unable to zero☐ Will not read applied input   |  |
| <ul><li>Calibration only</li><li>Data required</li><li>(attach any additional sheets as</li></ul> | ☐ Certificate of calibration required spaces (a necessary)                            |  |
| Also, describe signal source.  Where is the measurement beir                                      | ng performed? (factory, controlled laborato   | ry, out-of-doors, etc.)                          |
| There is the measurement being  | is periorited. (lactory, controlled laborate  | 1, out of doors, etc.)                           |
| What power line voltage is use  | d?  | Ambient temperature?°F                           |
| Relative humidity?  | Other?  |  |
| Any additional information. (If   | special modifications have been made by   | the user, please describe.)                      |



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